

Thermo-mechanical measurements on thin ladders under air-cooling or micro-channel cooling

(work performed within the DEPFET collaboration)

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Outline

- MCC introduction
- Test setup
- Test results:
 - Thermal results
 - Mechanical results
- Conclusions

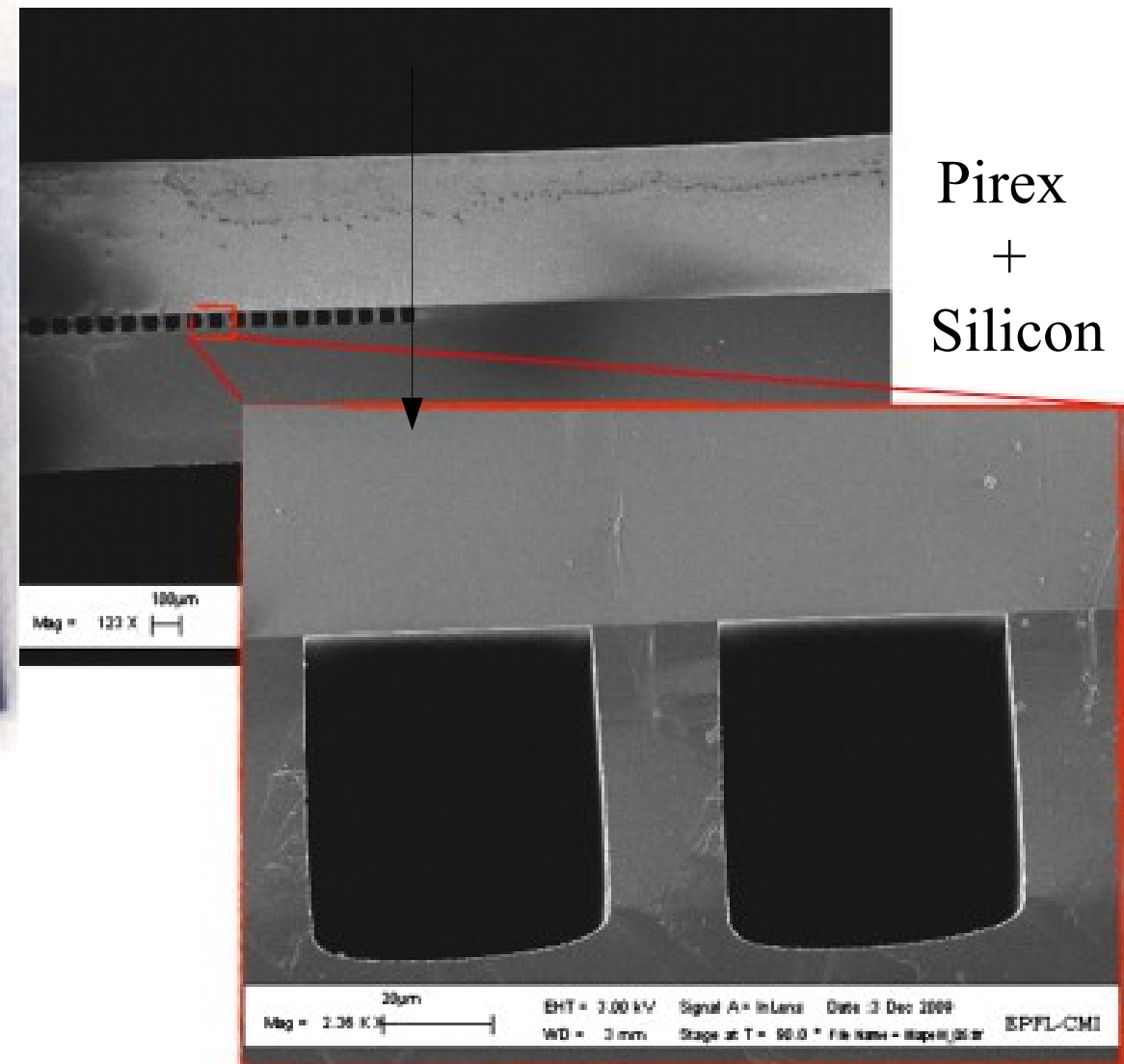


Introduction

Current R&D: LHCb*



MCC of 60-70
mm DH



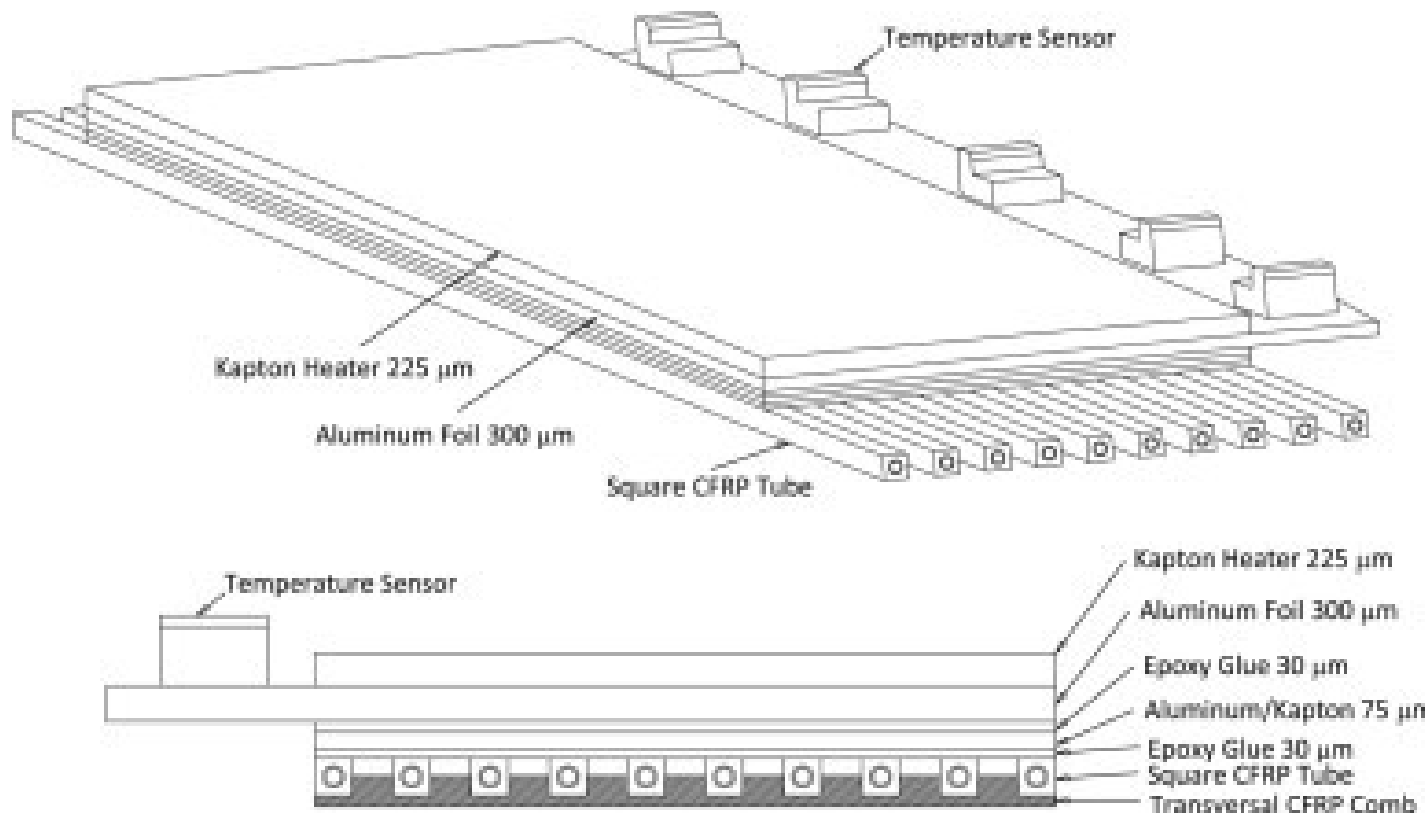
- Low $T < -20^{\circ}\text{C}$ \rightarrow two phase CO_2
- $1,8\text{W}/\text{cm}^2$
- Out-of-plane connexion

*J. Buytaert, et al. "Micro channel evaporative CO_2 cooling for the upgrade of the LHCb vertex detector", 2013, Nuclear Instruments and Methods in Physics Research Section A: Accelerators, Spectrometers, Detectors and Associated Equipment, Vol. 731



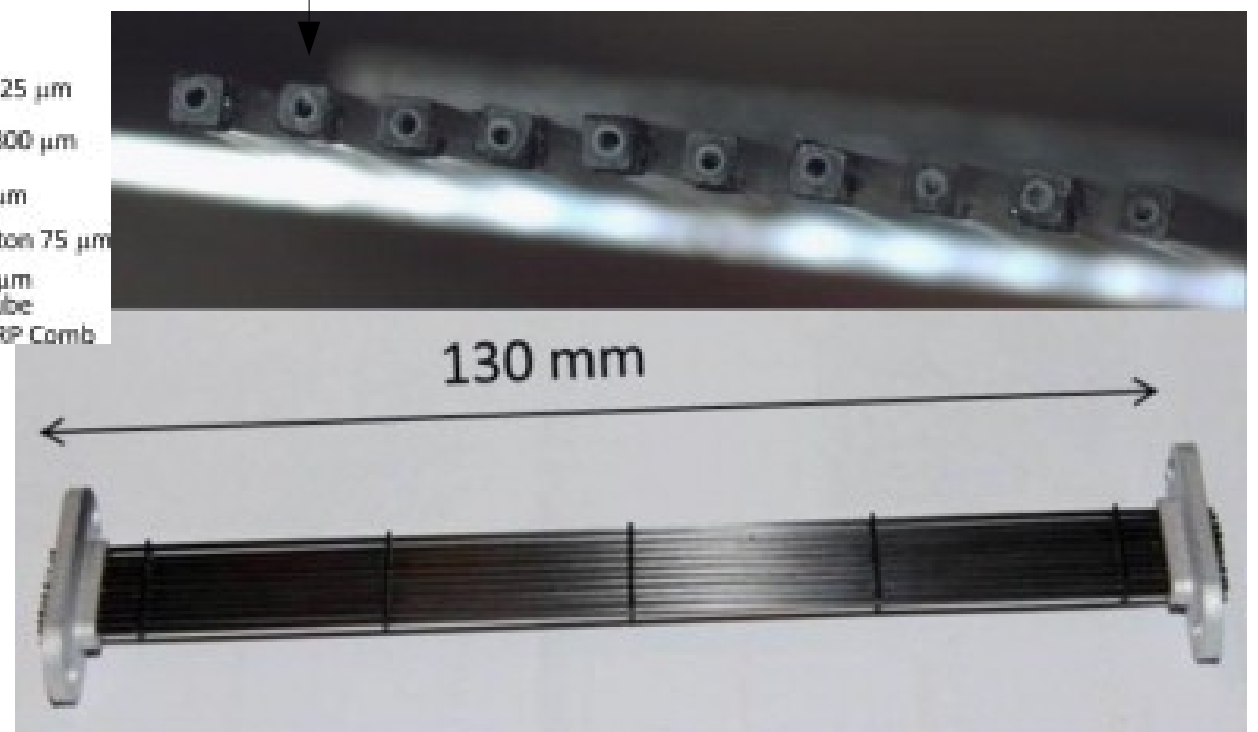
Introduction

Current R&D: SuperB Silicon Vertex Tracker*



CFRP + aluminium

MCC of 0,3 mm
DH



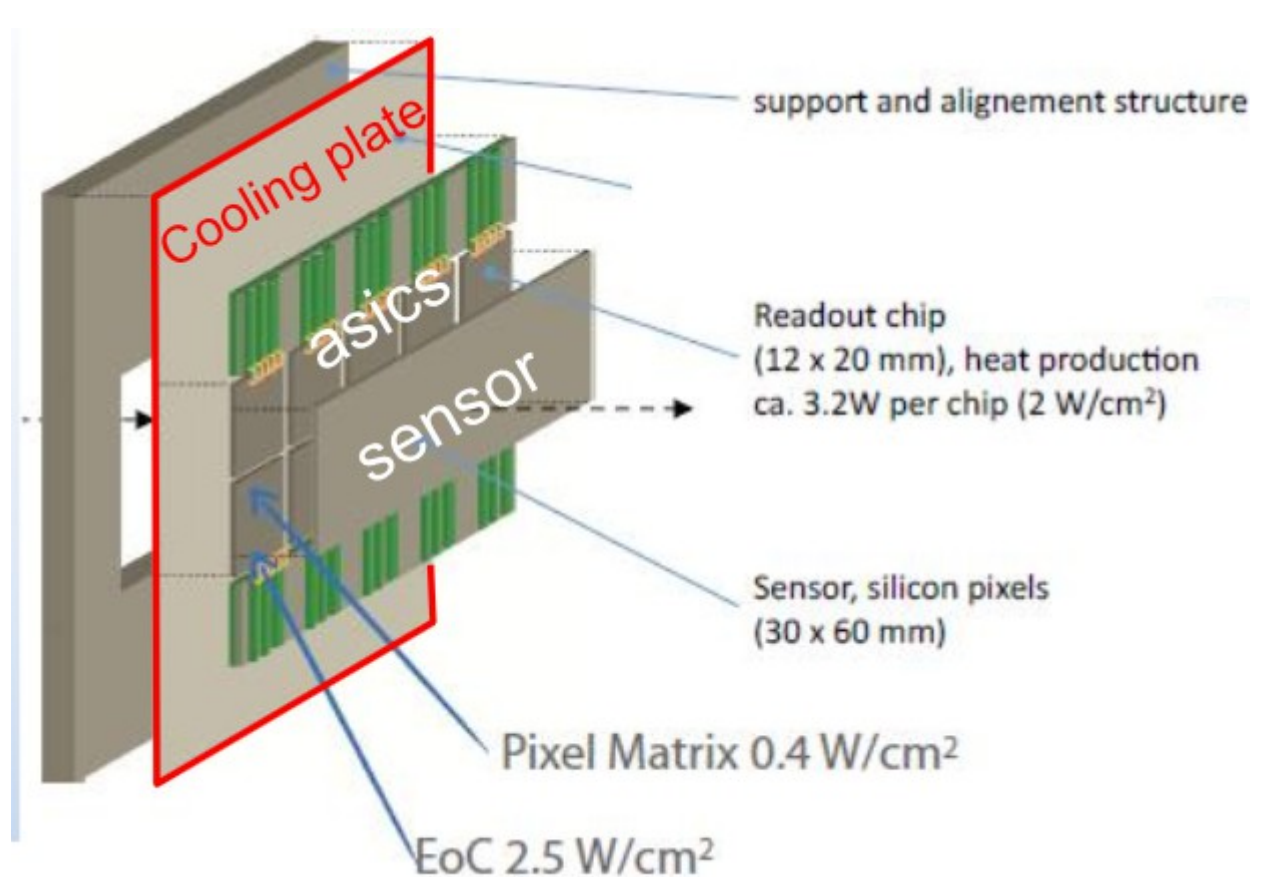
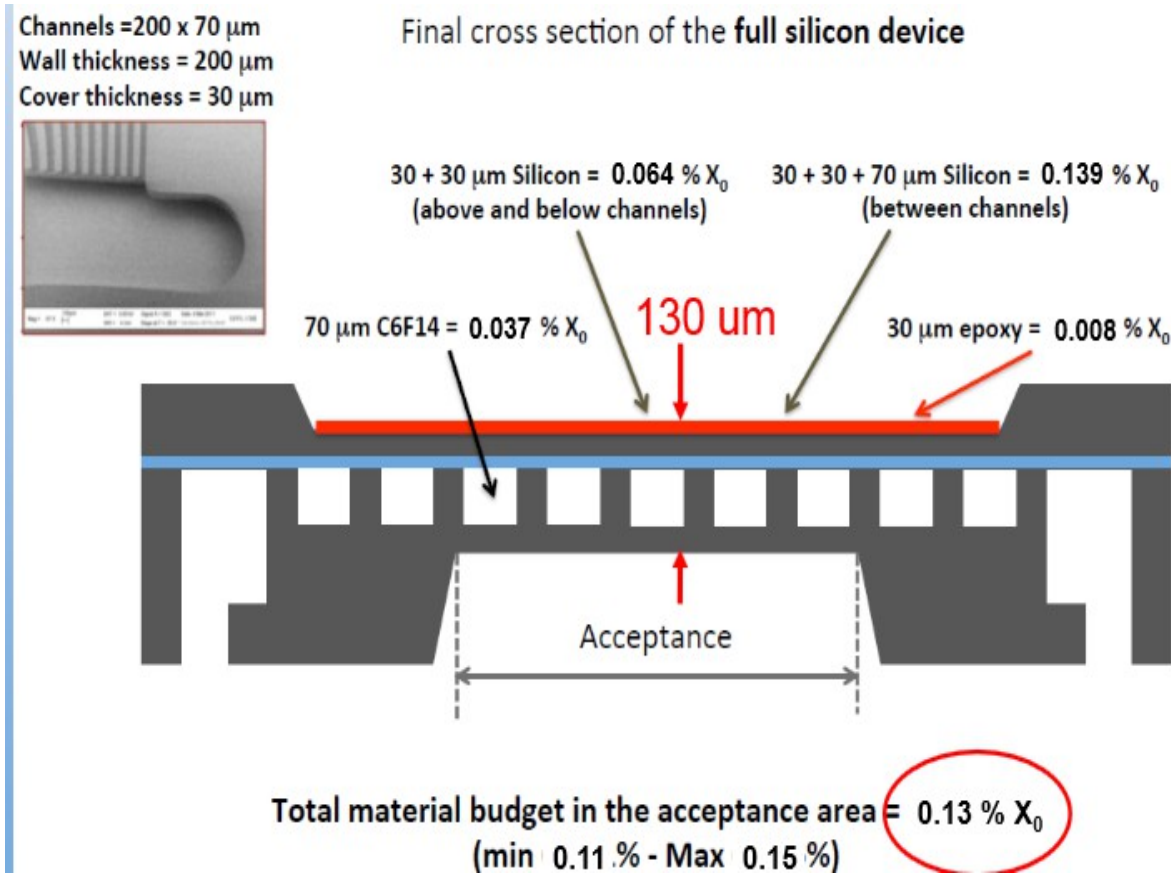
- Single phase coolant (50%water, 50% ethylene glycol)
- About $1-3\text{W}/\text{cm}^2$ of heat dissipation
- In-plane connexion

*F. Bossi, et al. "Light prototype support using micro-channel technology as high efficiency system for silicon pixel detector cooling", 2011, Nuclear Instruments and Methods in Physics Research Section A: Accelerators, Spectrometers, Detectors and Associated Equipment, Vol. 650



Introduction

Current R&D: NA62 GTK*



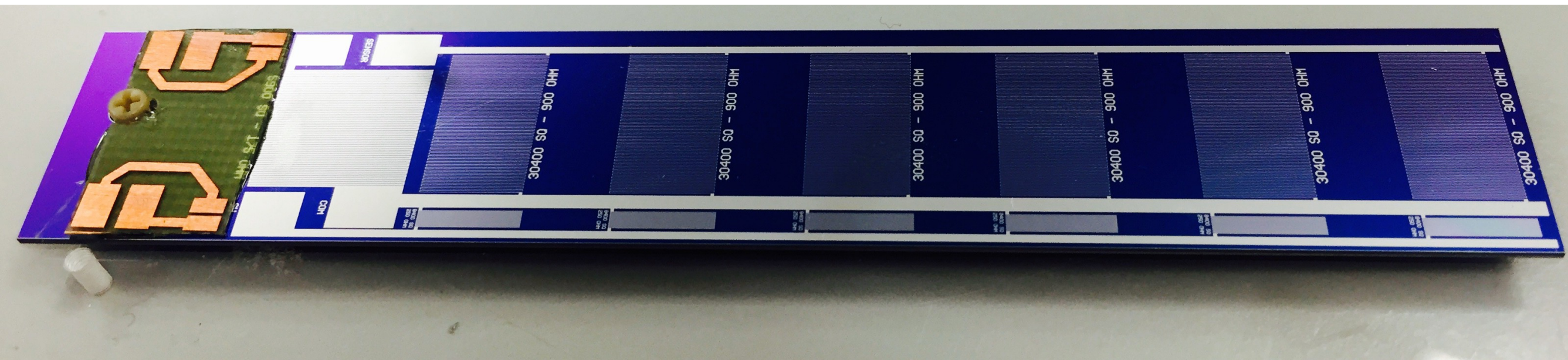
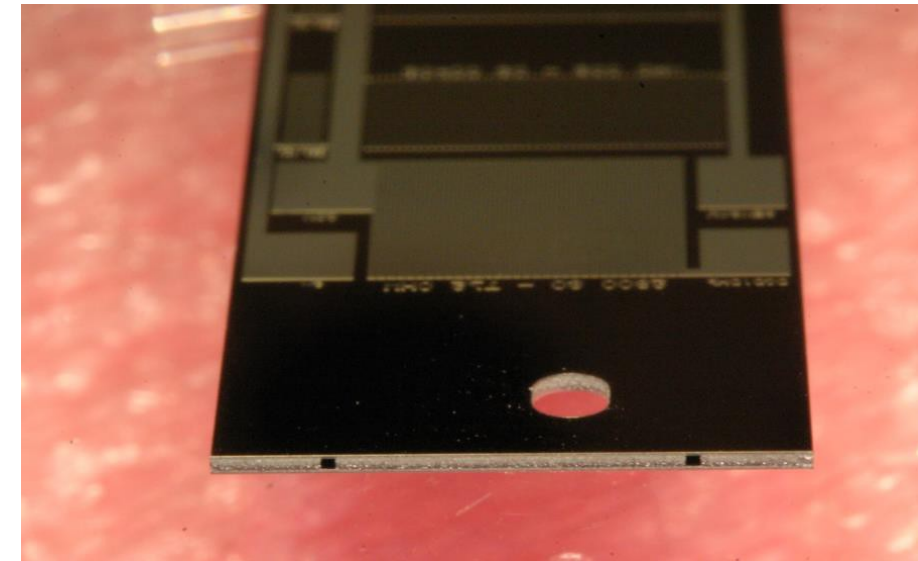
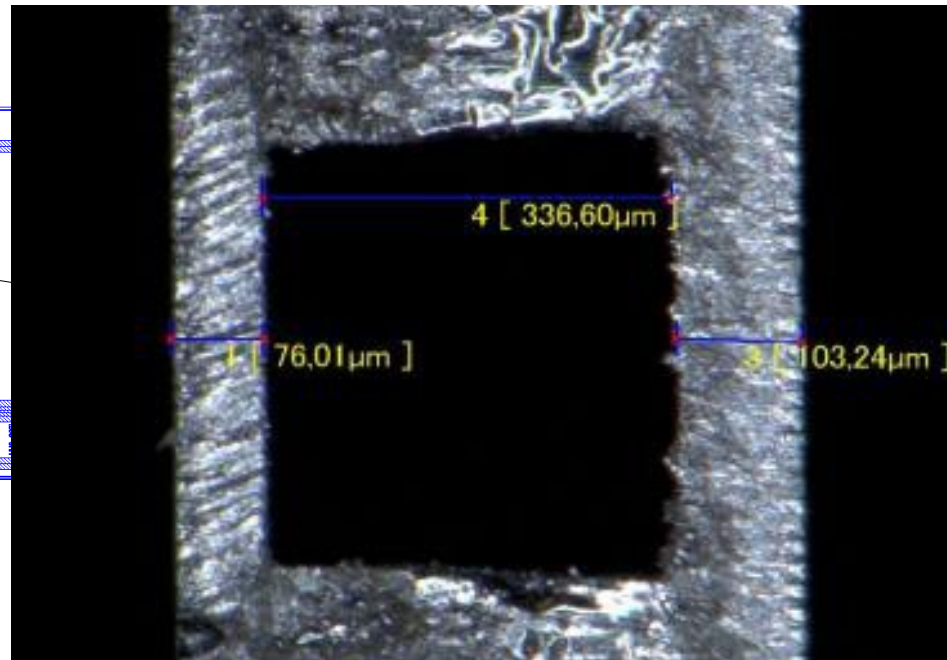
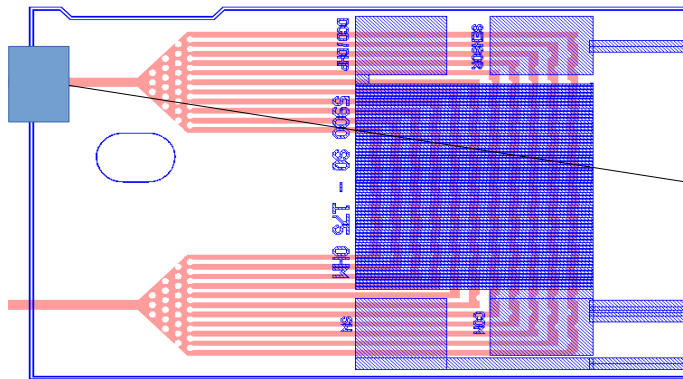
- Single phase coolant C6F14 T < -20°C
- 2,5W/cm² of heat dissipation
- Out-of-plane connexion

*G. Nüßle, A. Mapelli, M. Morel, P. Petagna, G. Romagnoli, and K. Howell (2014) NA62 GigaTracker Cooling with Silicon Micro Channels. Astroparticle, Particle, Space Physics and Detectors for Physics Applications: pp. 525-530



Introduction

Silicon ladder with MCC embedded in the sensor

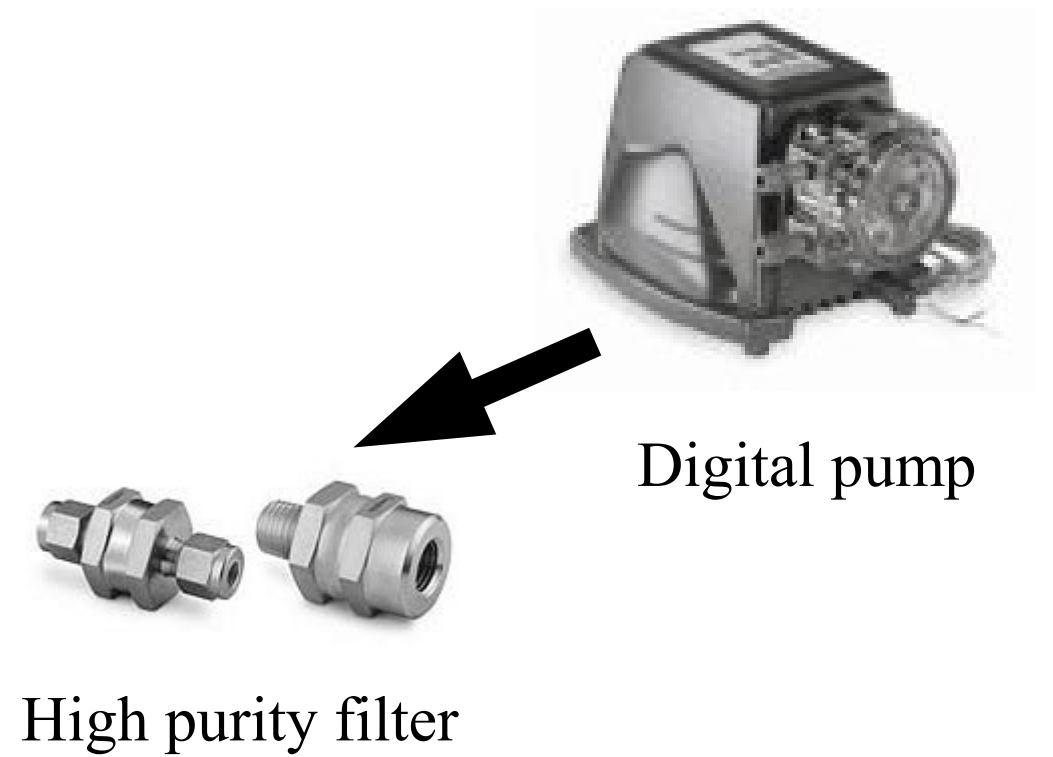


Test setup

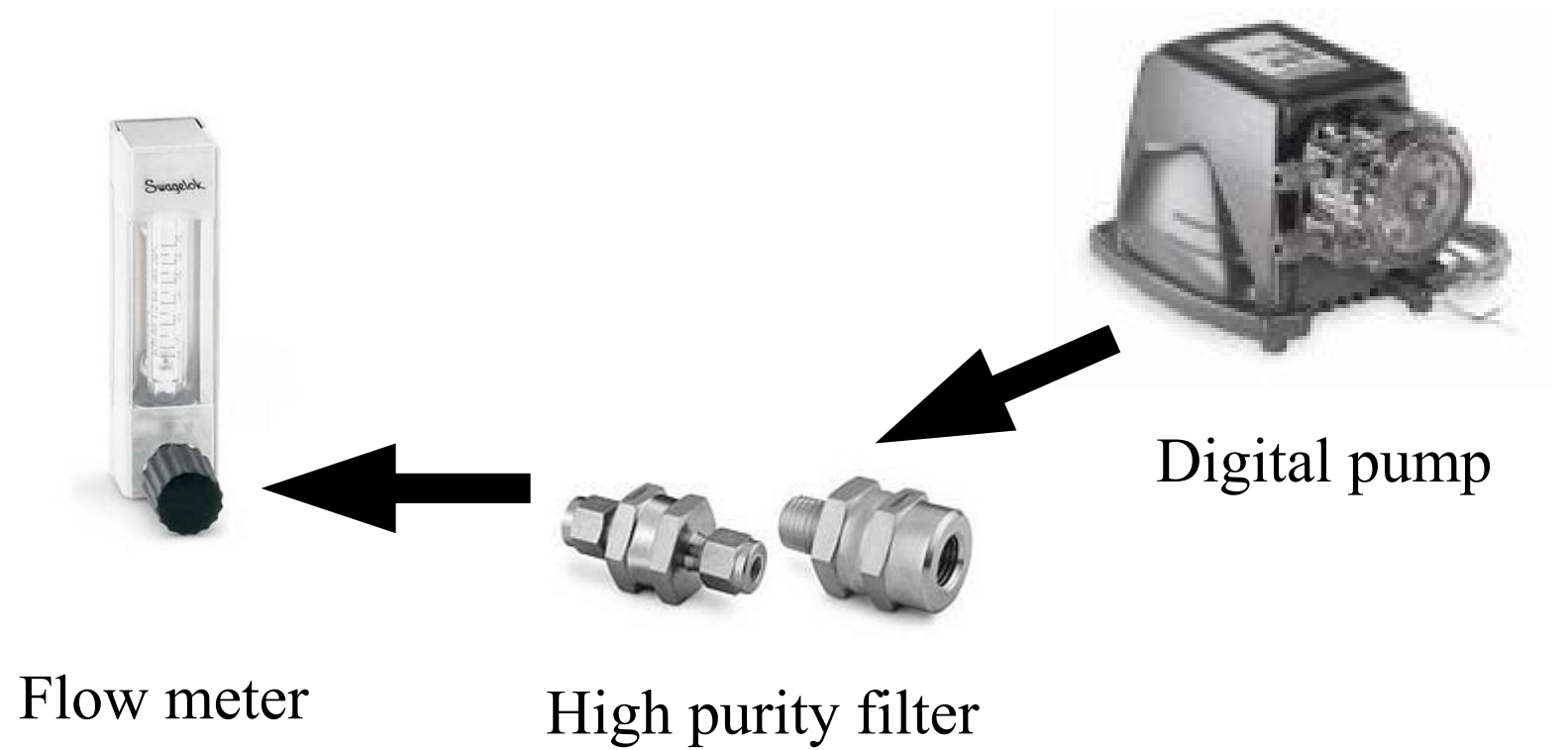


Digital pump

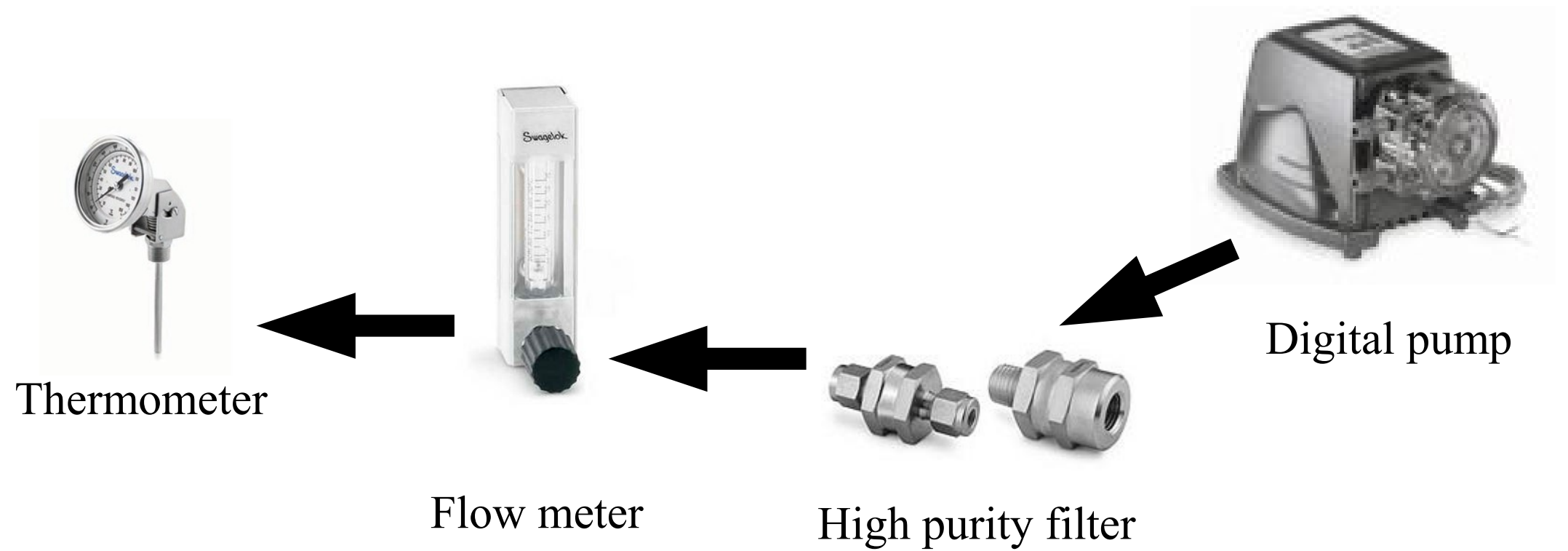
Test setup



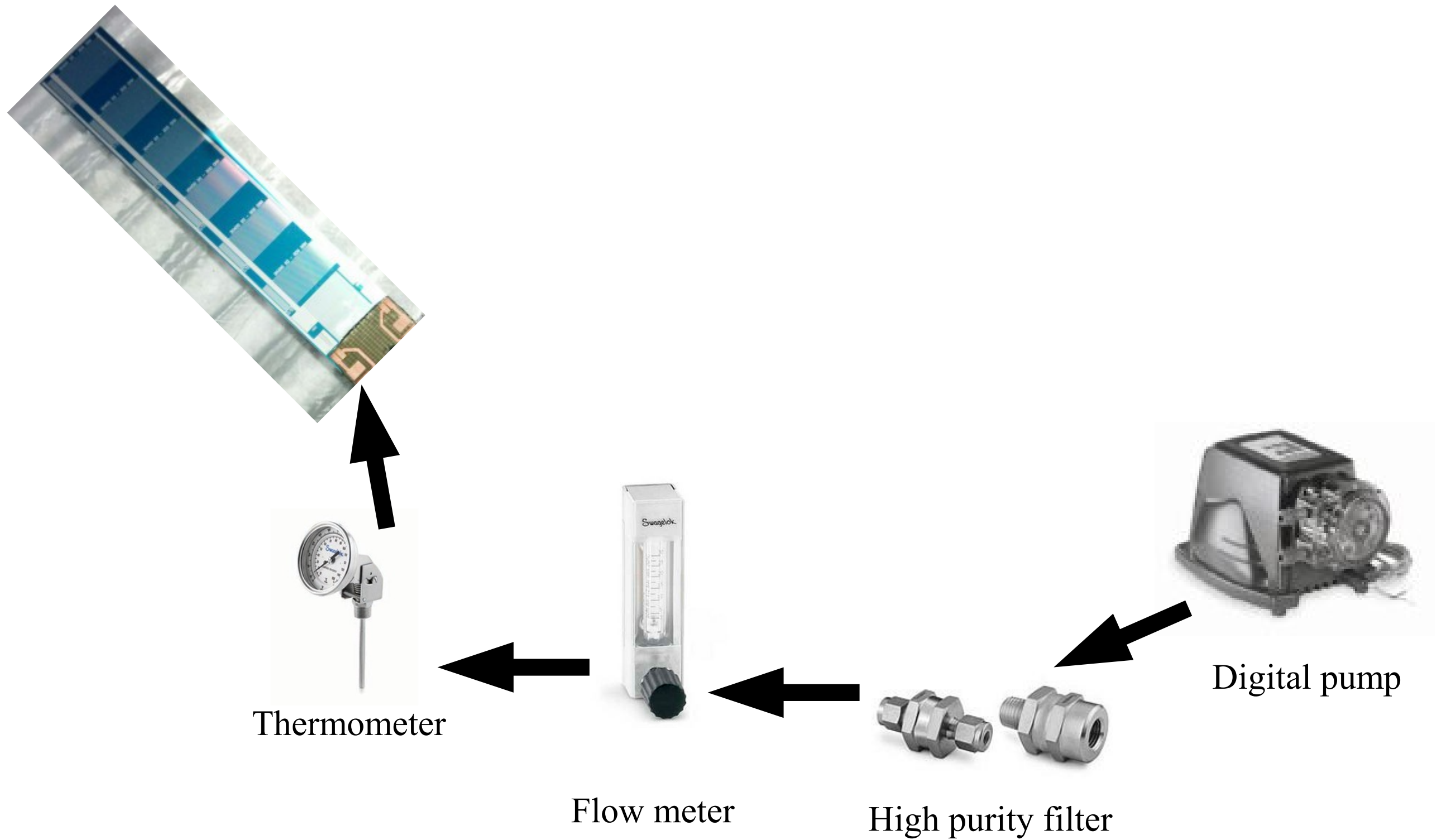
Test setup



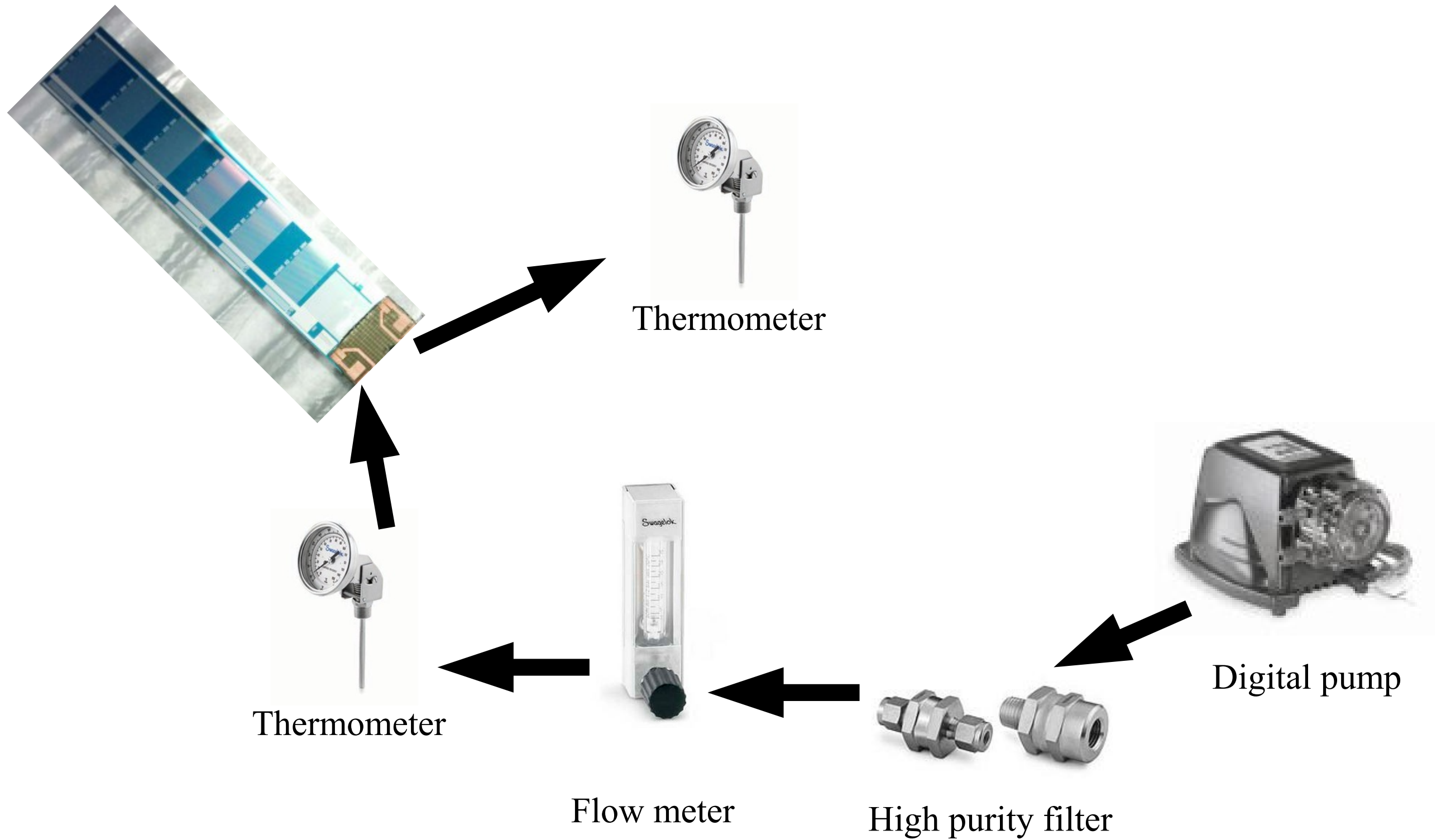
Test setup



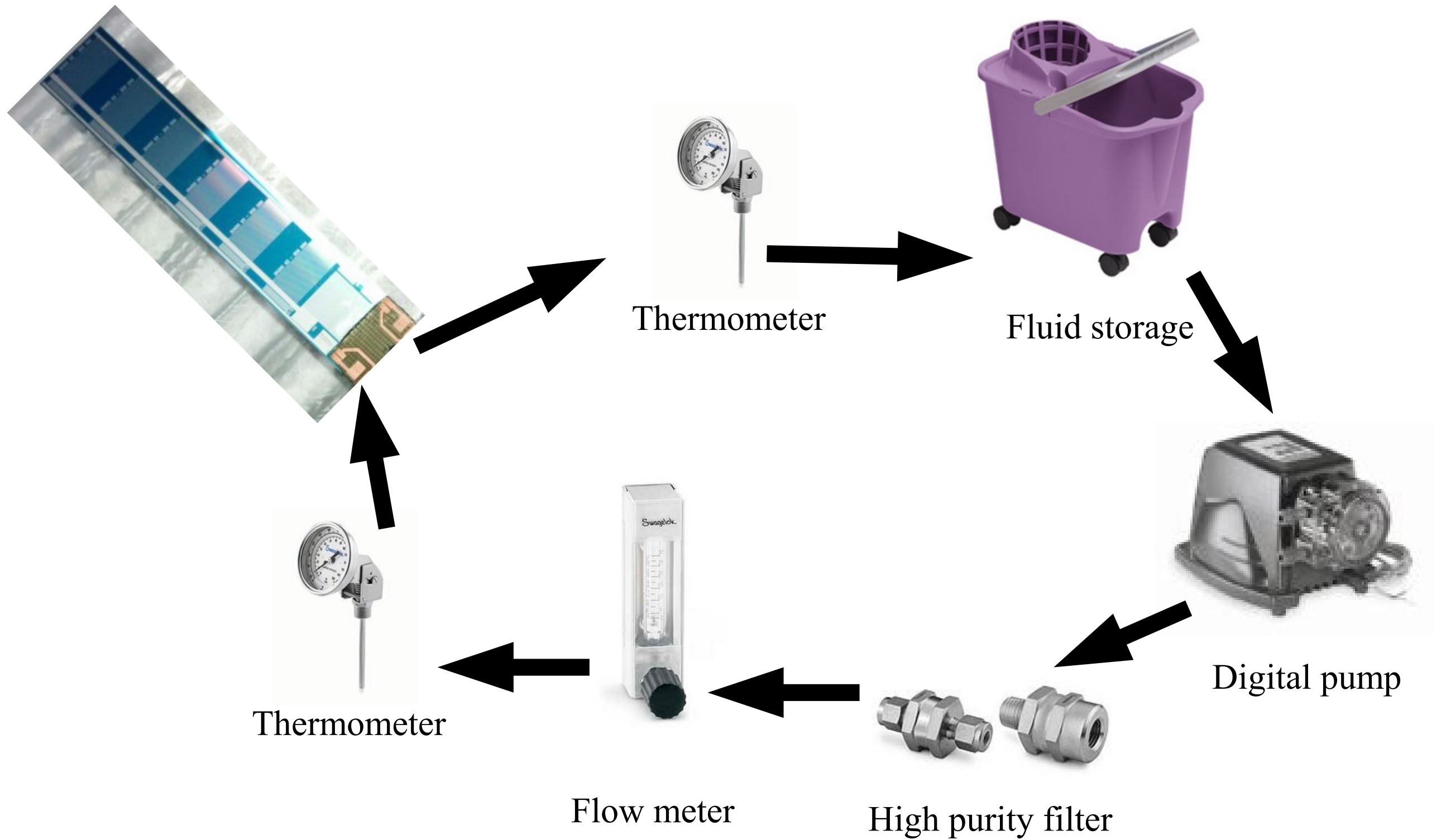
Test setup



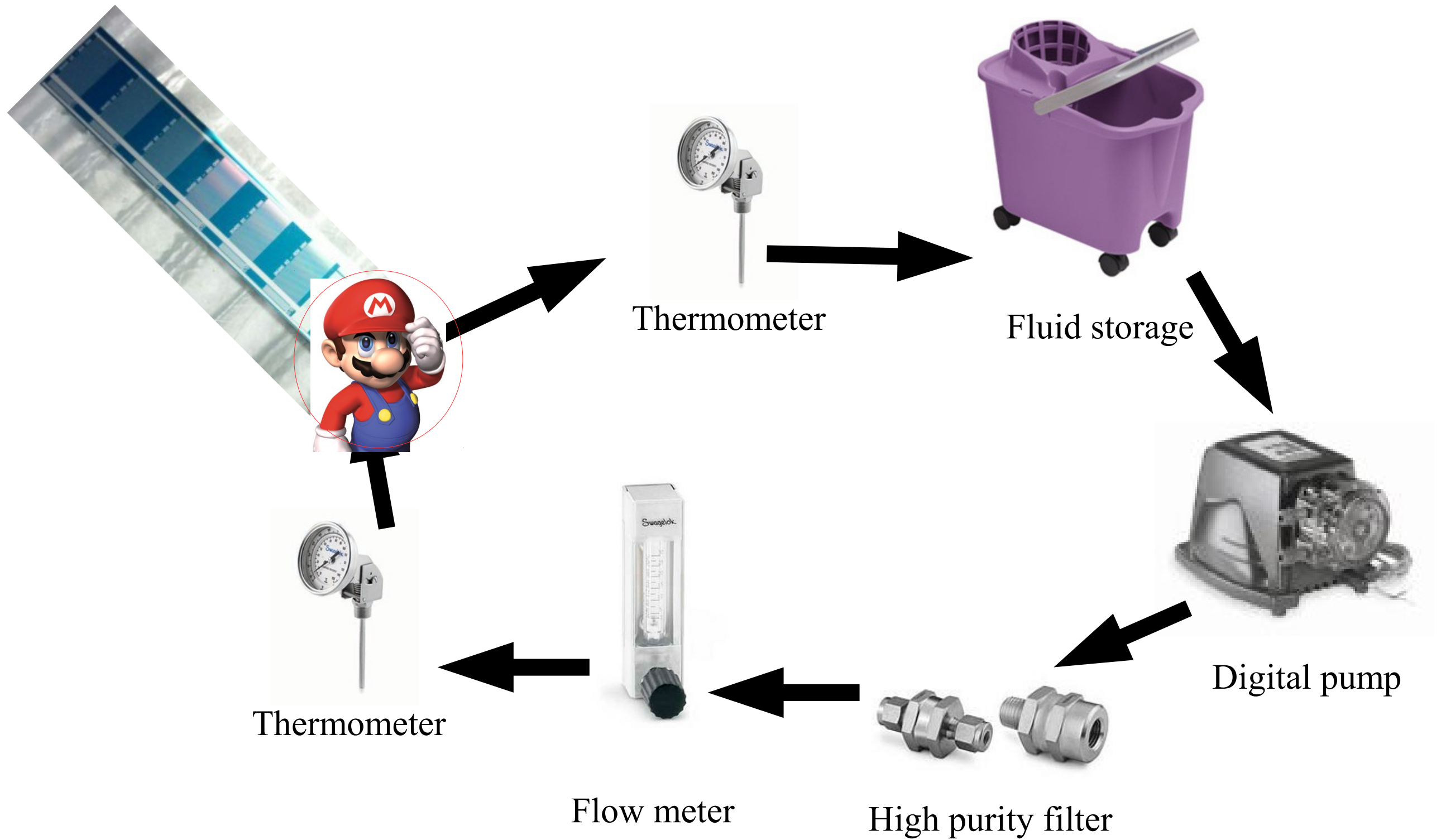
Test setup



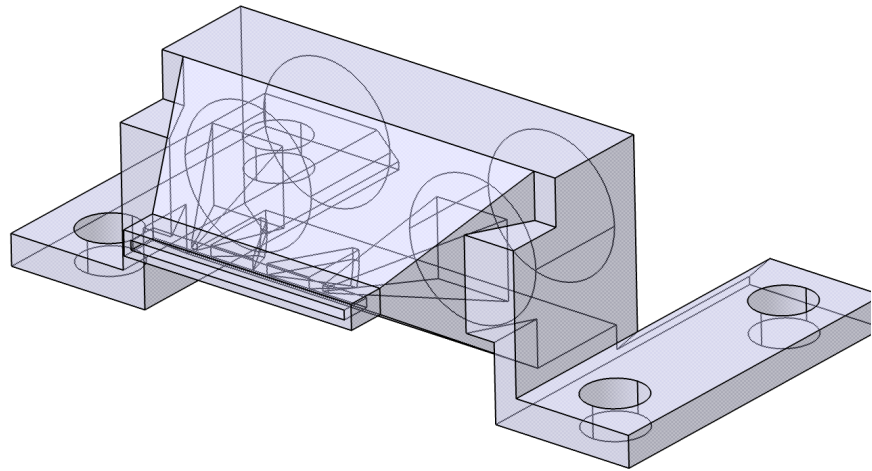
Test setup



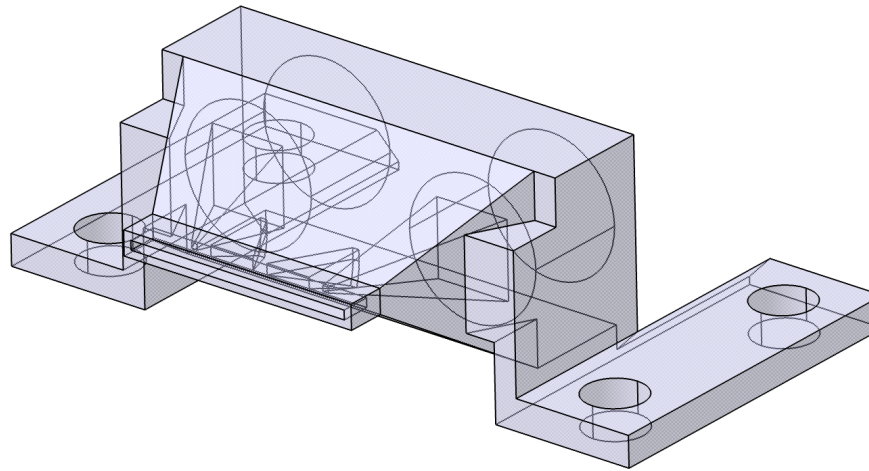
Test setup



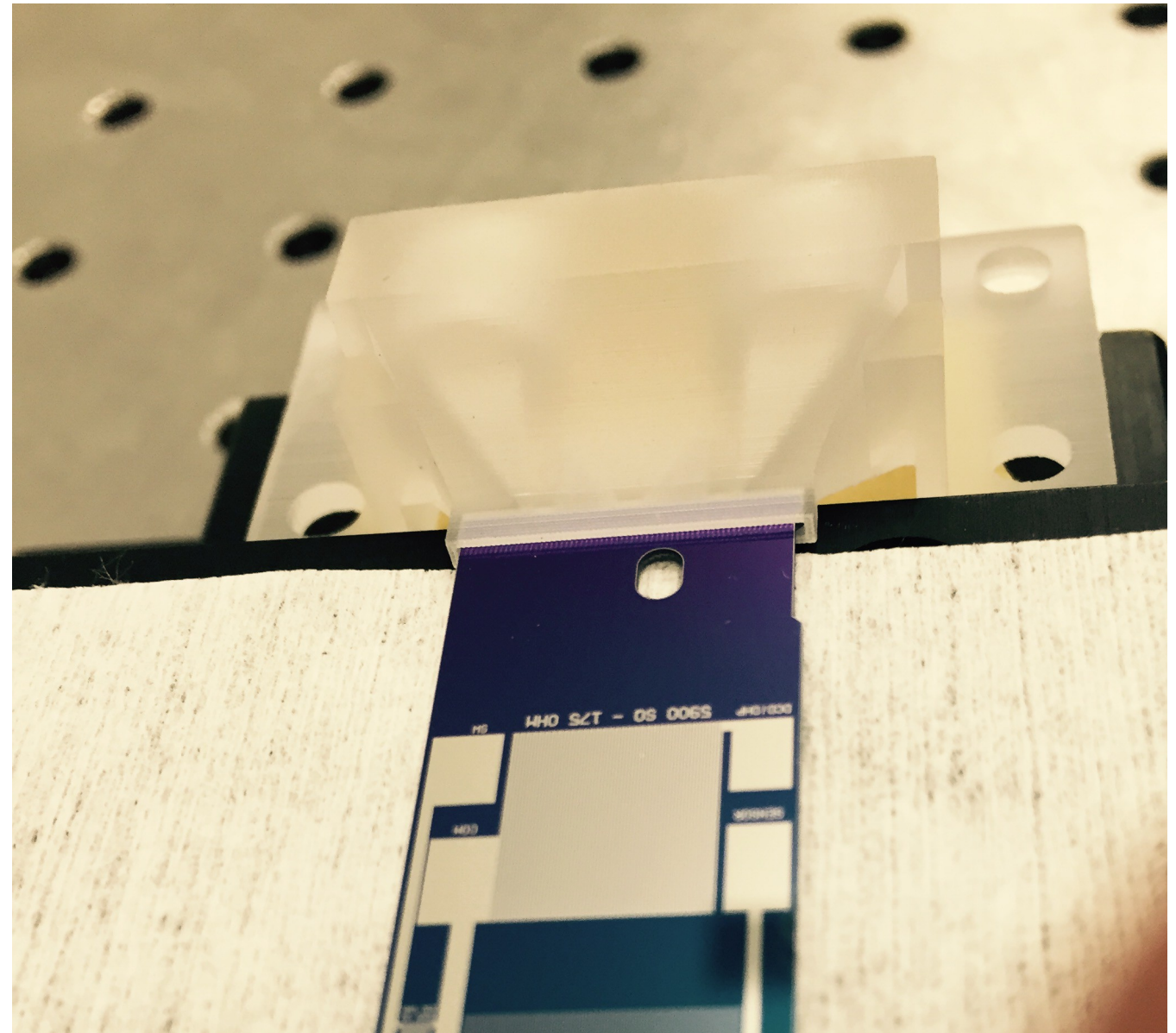
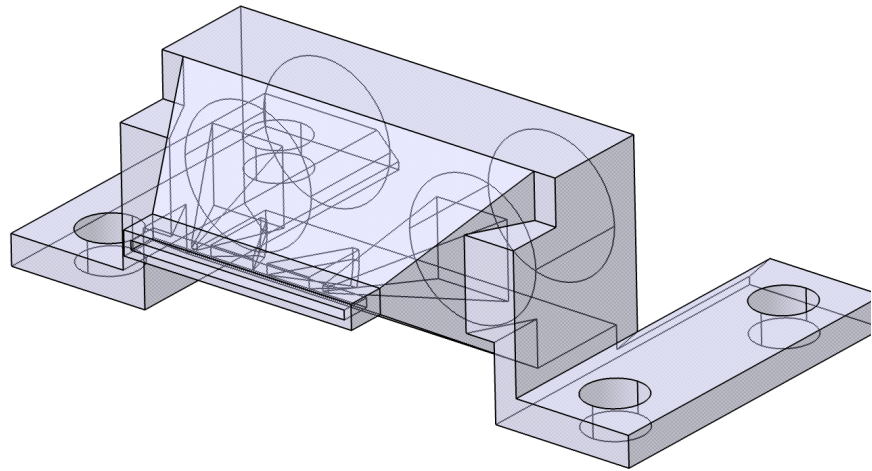
Test setup



Test setup

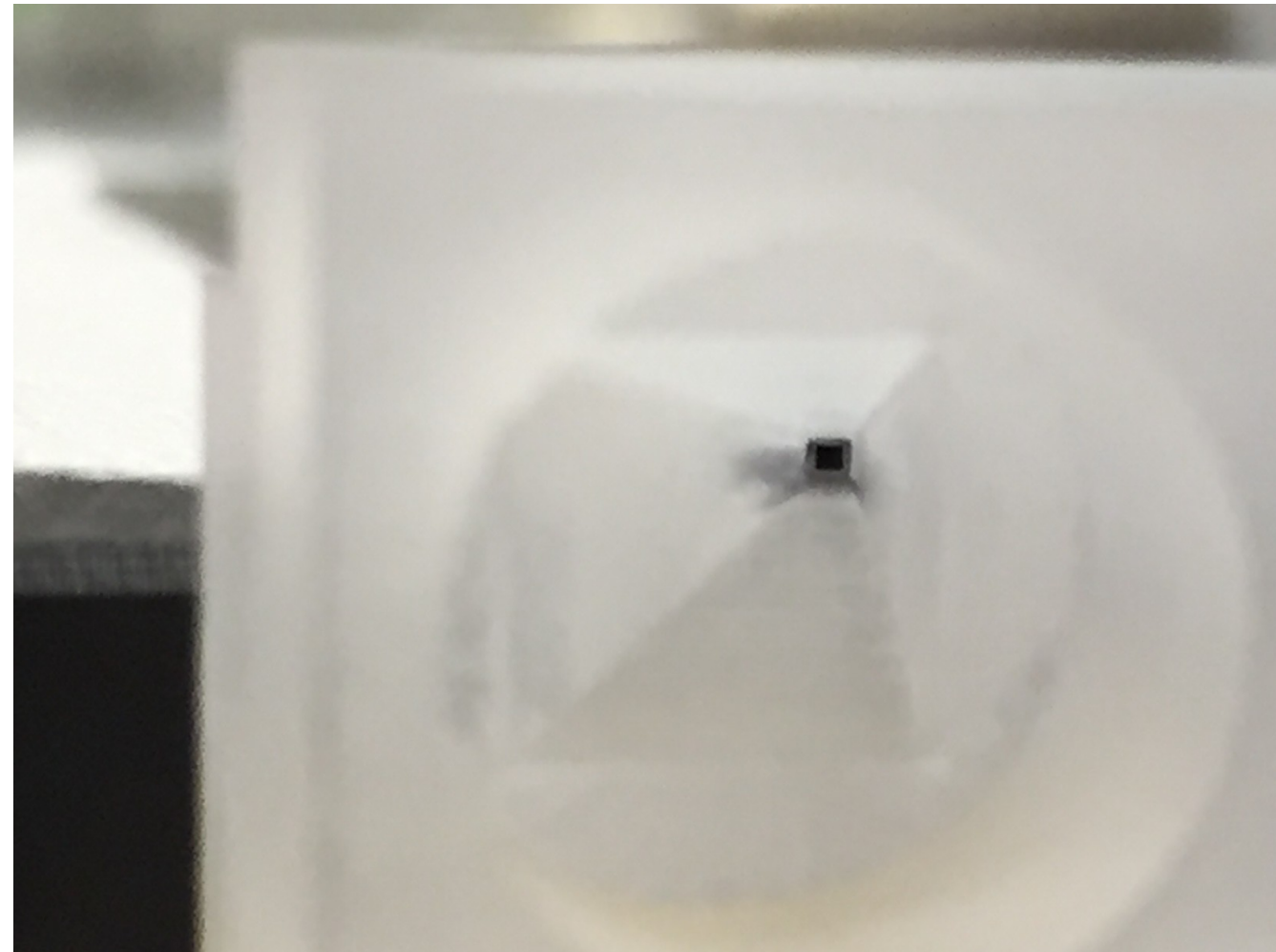
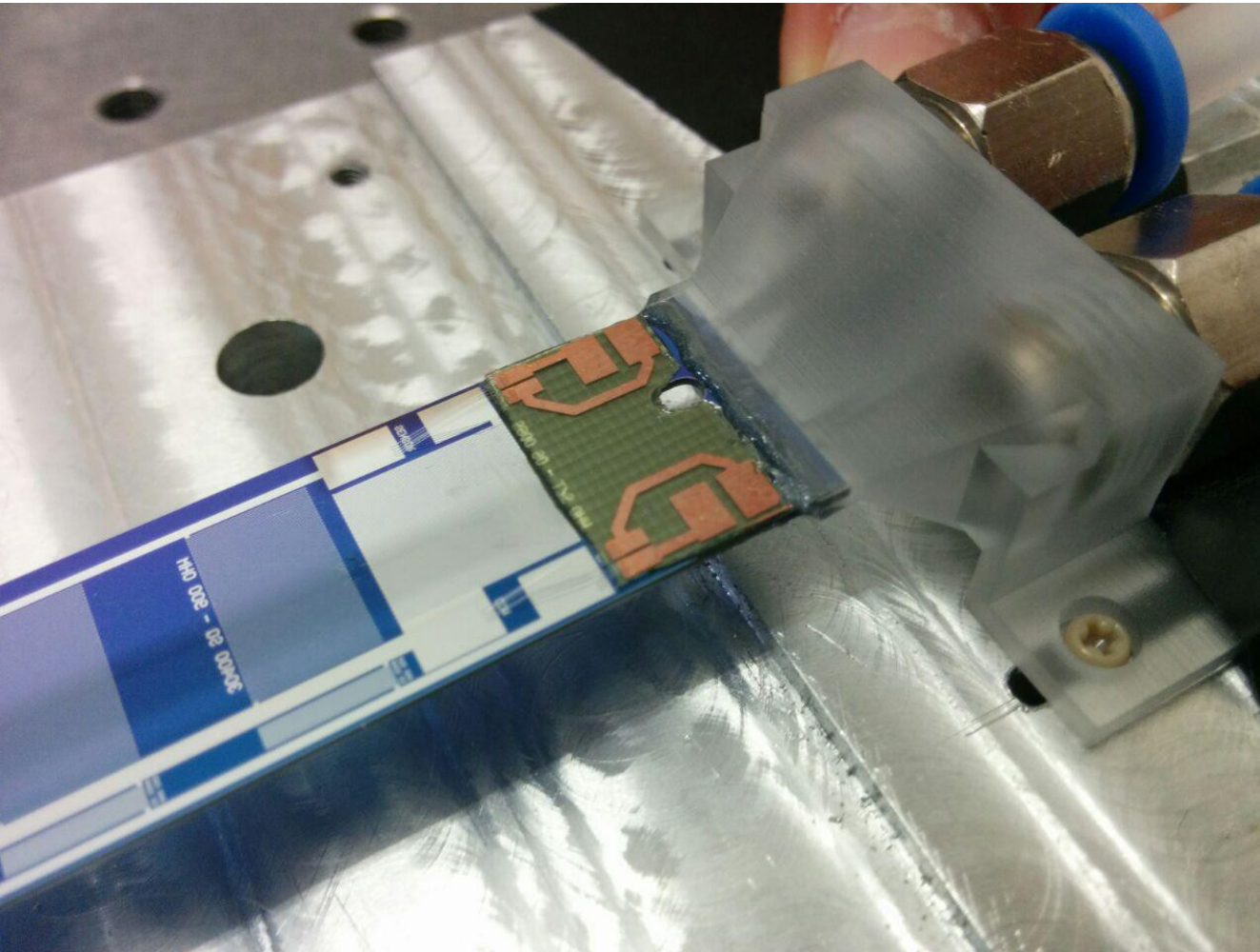


Test setup

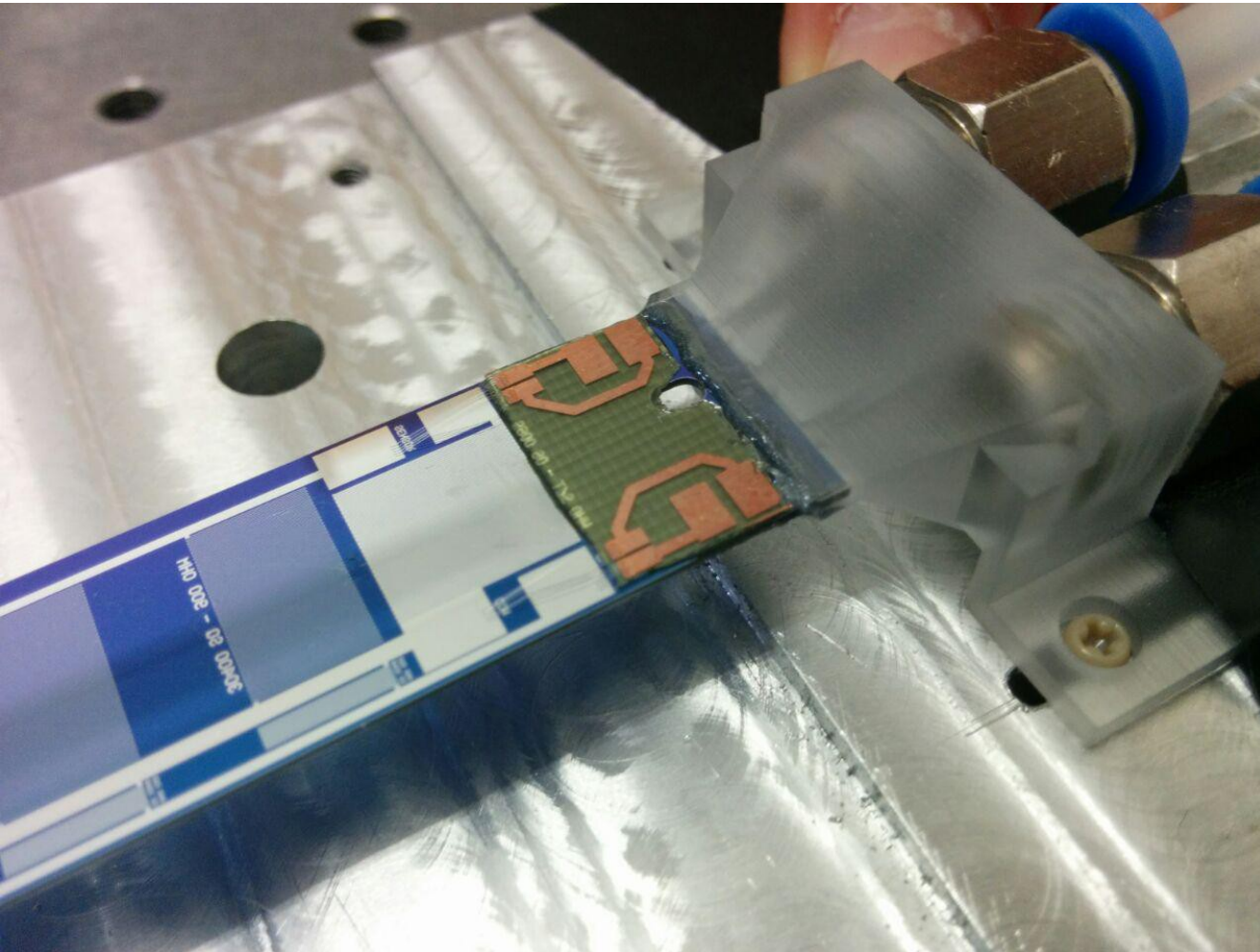


- Stereolithography technology:
 - 15 μ m precision
 - 300 μ m per layer

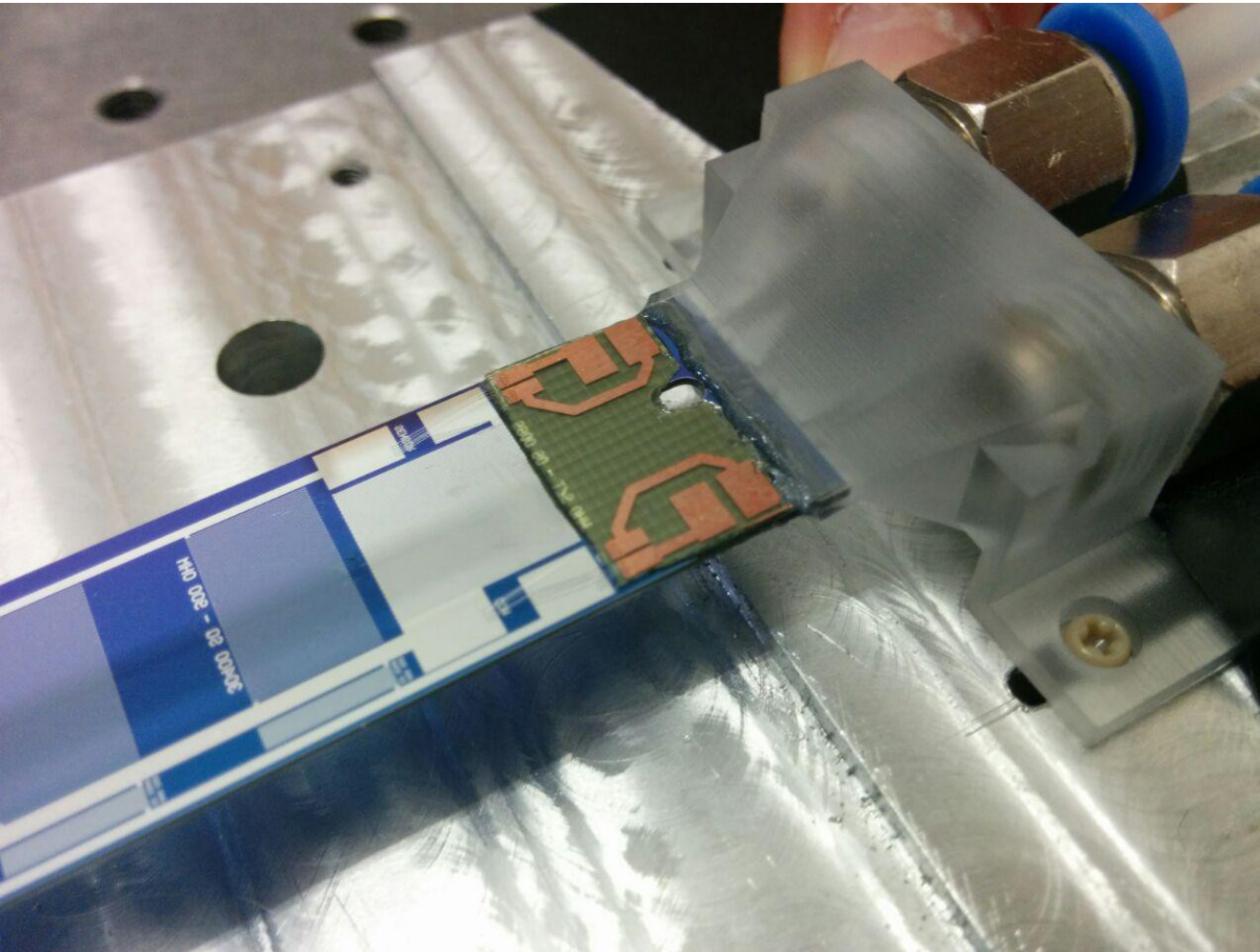
Test setup



Test setup



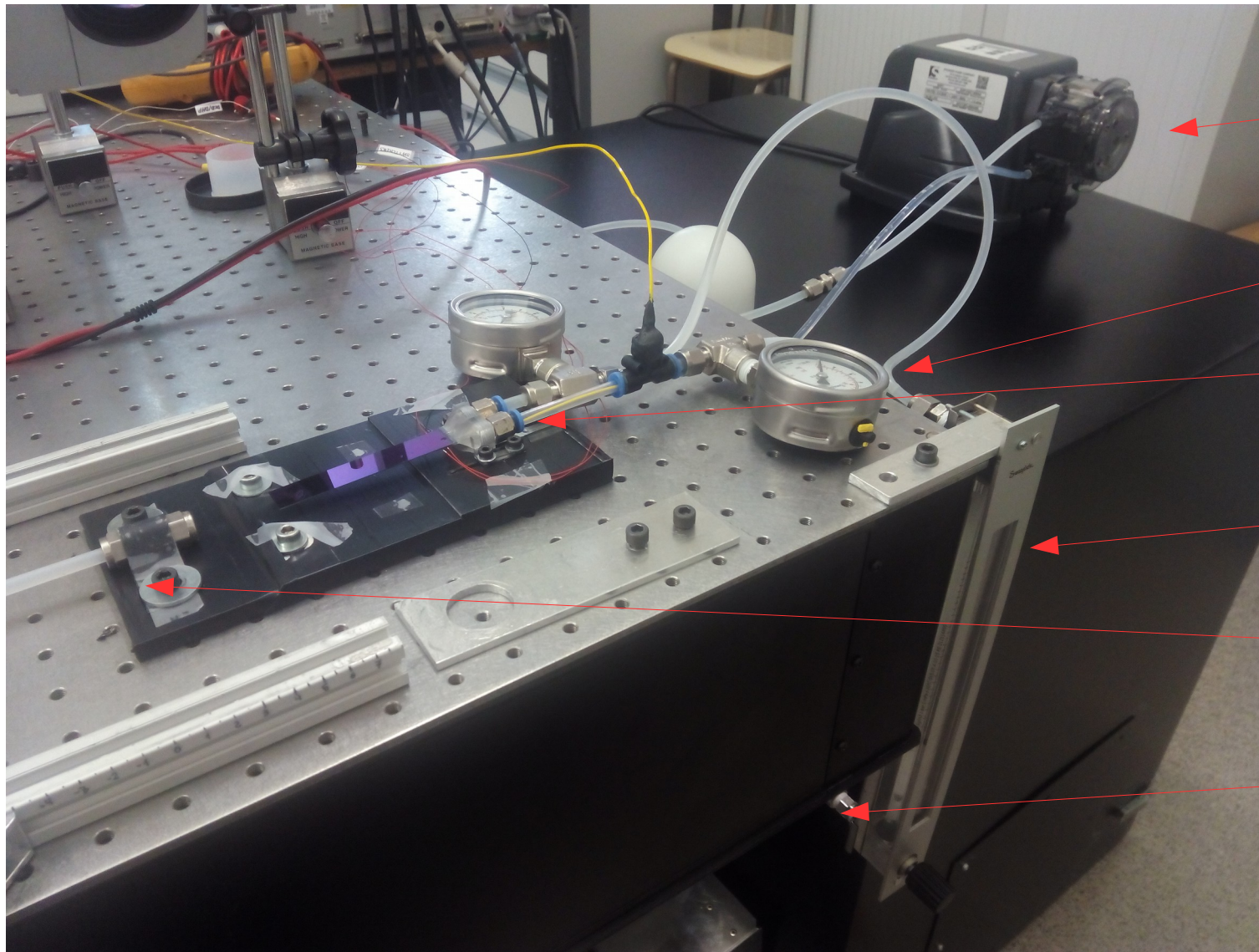
Test setup



- Self-aligning
- Sealed with glue
- Success rate 3/3
- Adaptor from high pressure commercial elements to MCC Si-detector application



Test setup



Water pump

Pressure gauges

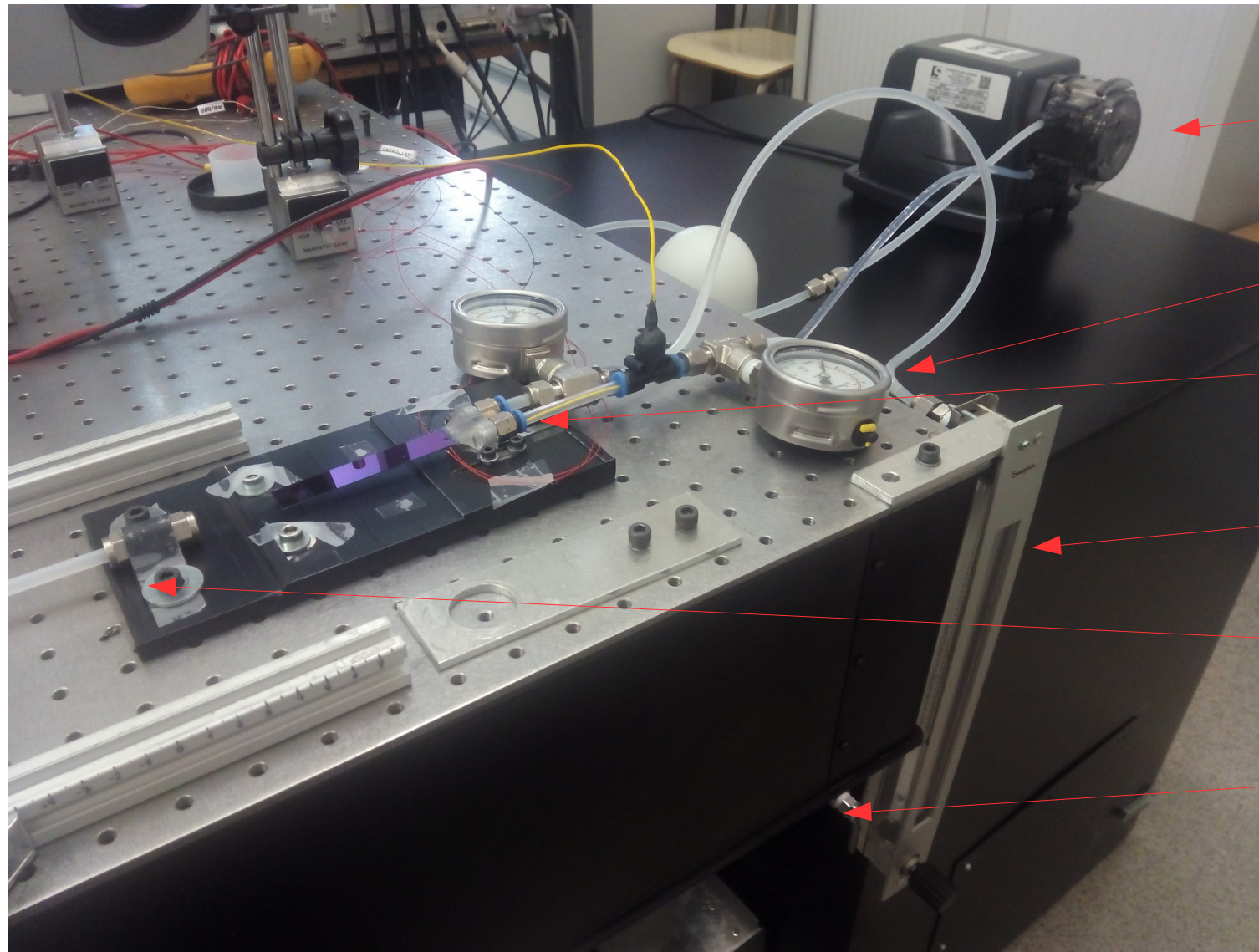
Pt100 (Temperature)

Flow meter

Air cooling (0,5m/s)

Filter

Test setup



Water pump

Pressure gauges

Pt100 (Temperature)

Flow meter

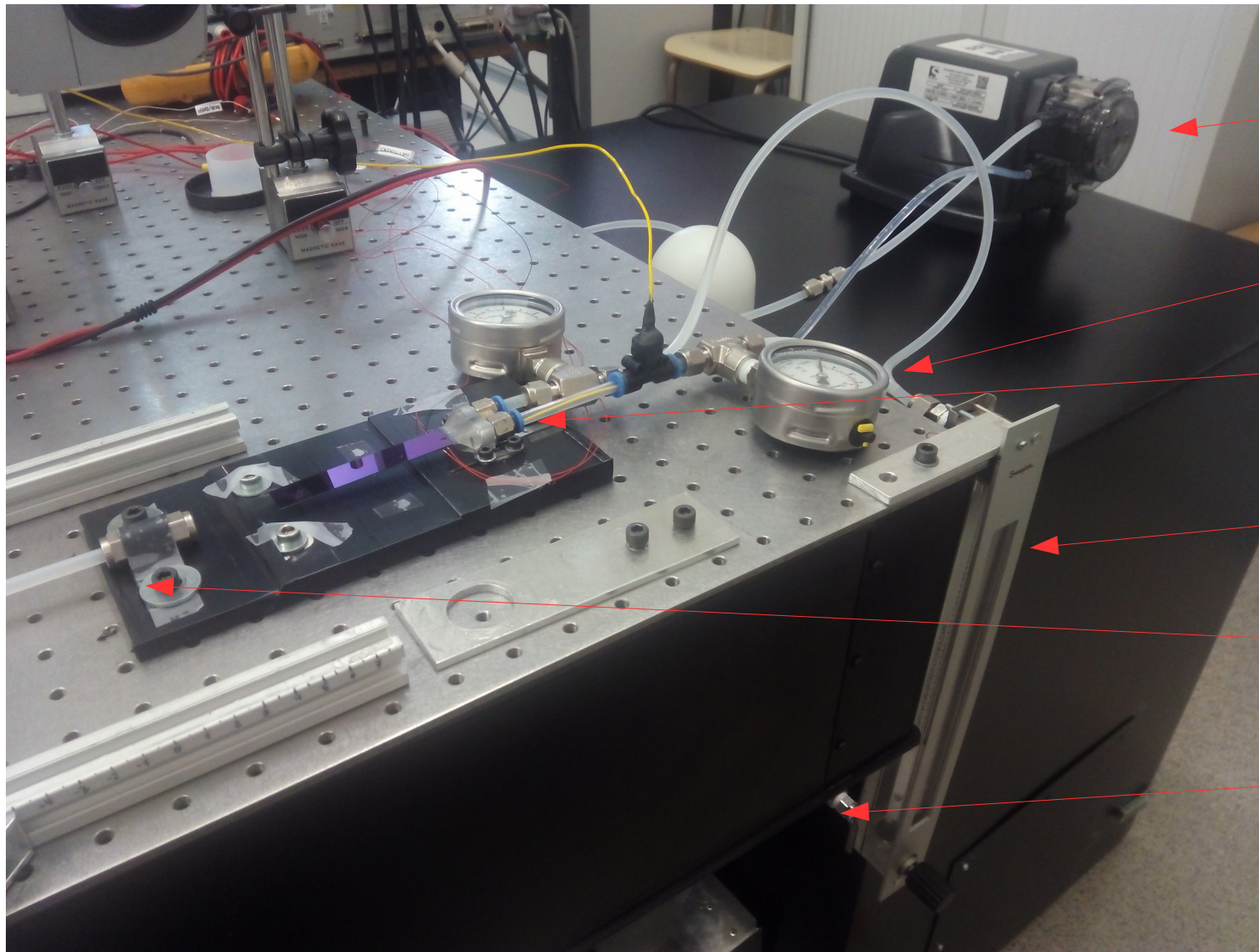
Air cooling (0,5m/s)

Filter

- For Si-sensors operating above 0°C mono-phase fluid is chosen (water)
- Controlled environment to quantify cooling performance
- Operated non-stop for a week with **no leaks, no clogging**



Test setup



Water pump

Pressure gauges

Pt100 (Temperature)

Flow meter

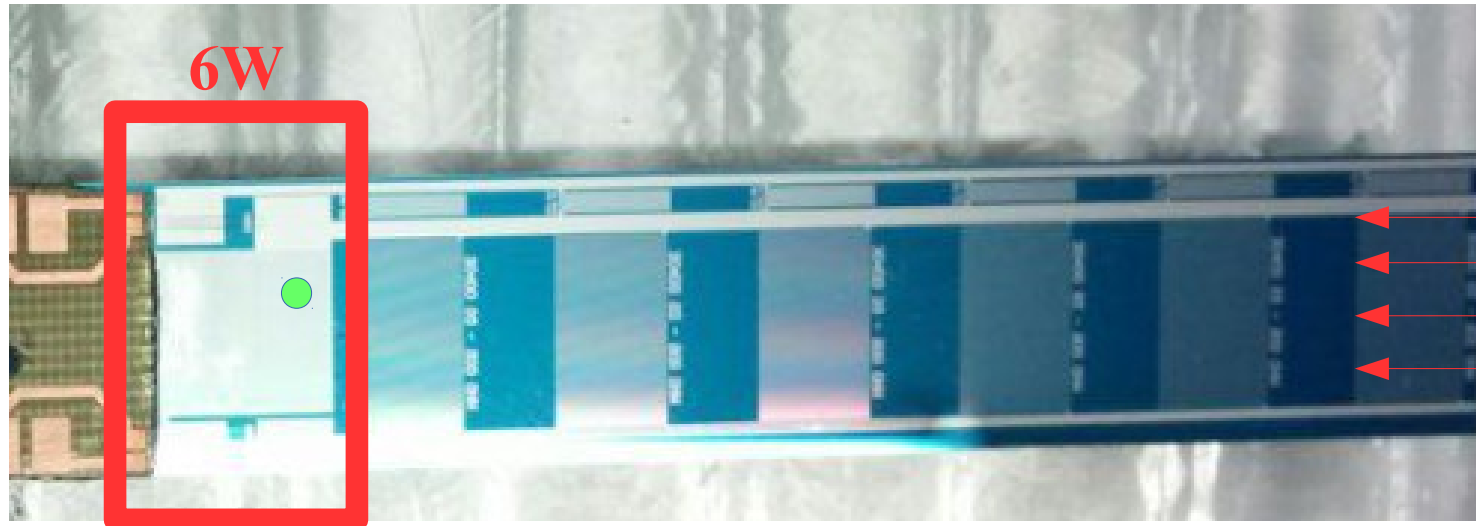
Air cooling (0,5m/s)

Filter

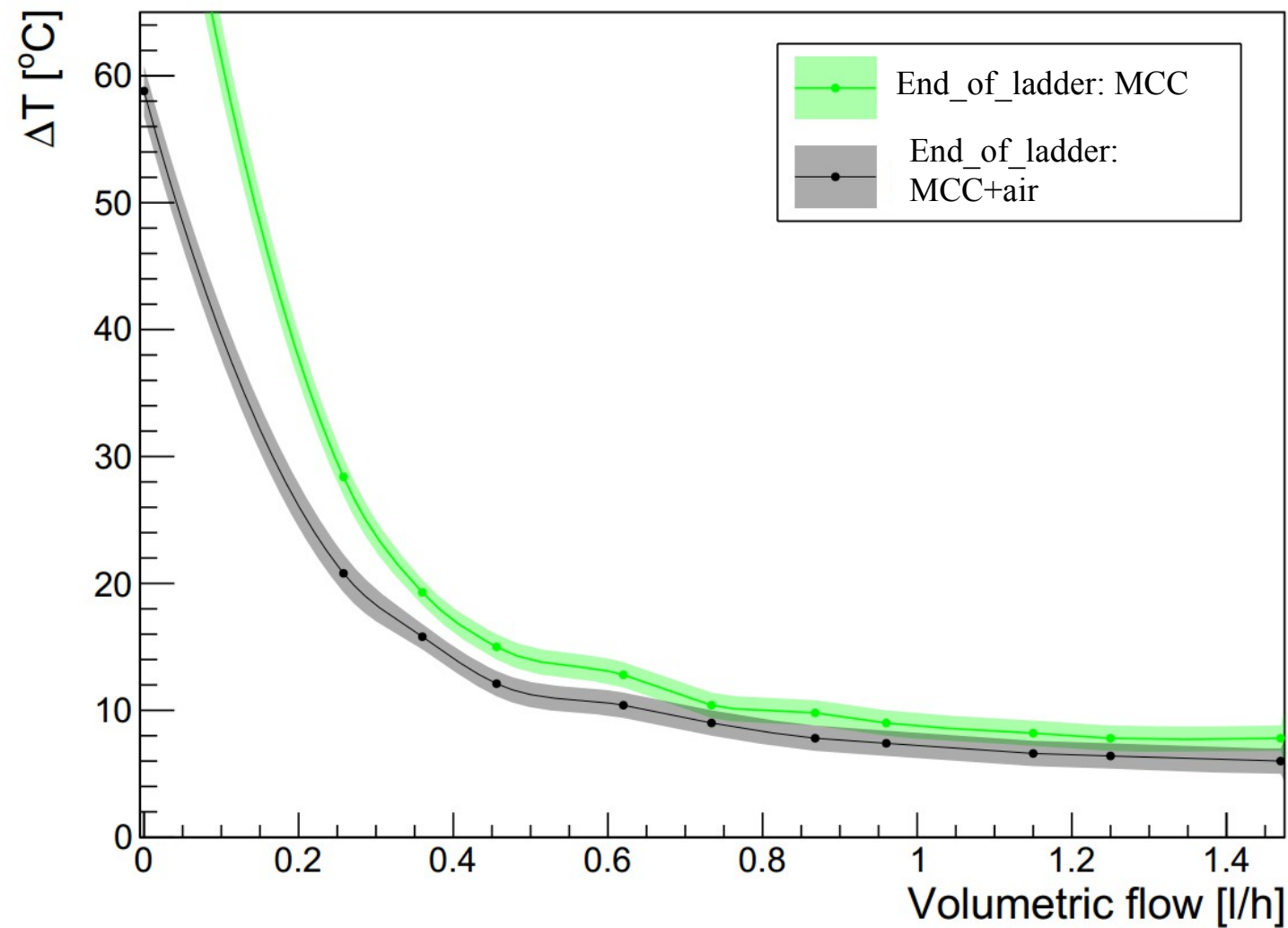
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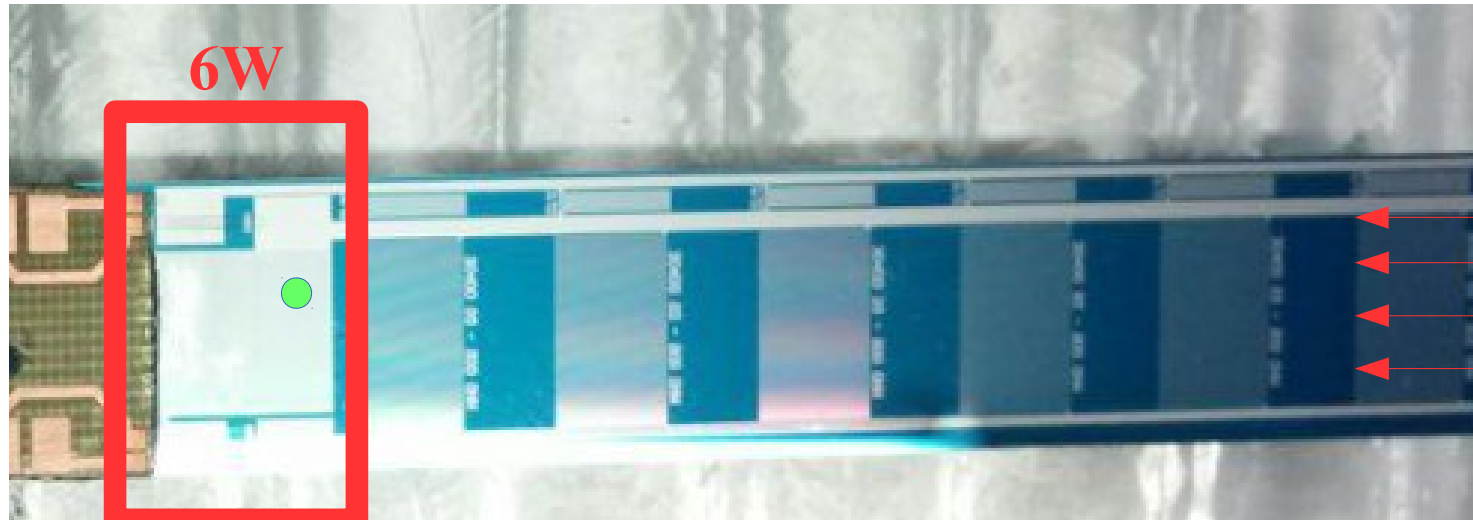
Test results: MCC+air (MCC region)



Air
(0,5 m/s)



Test results: MCC+air (MCC region)



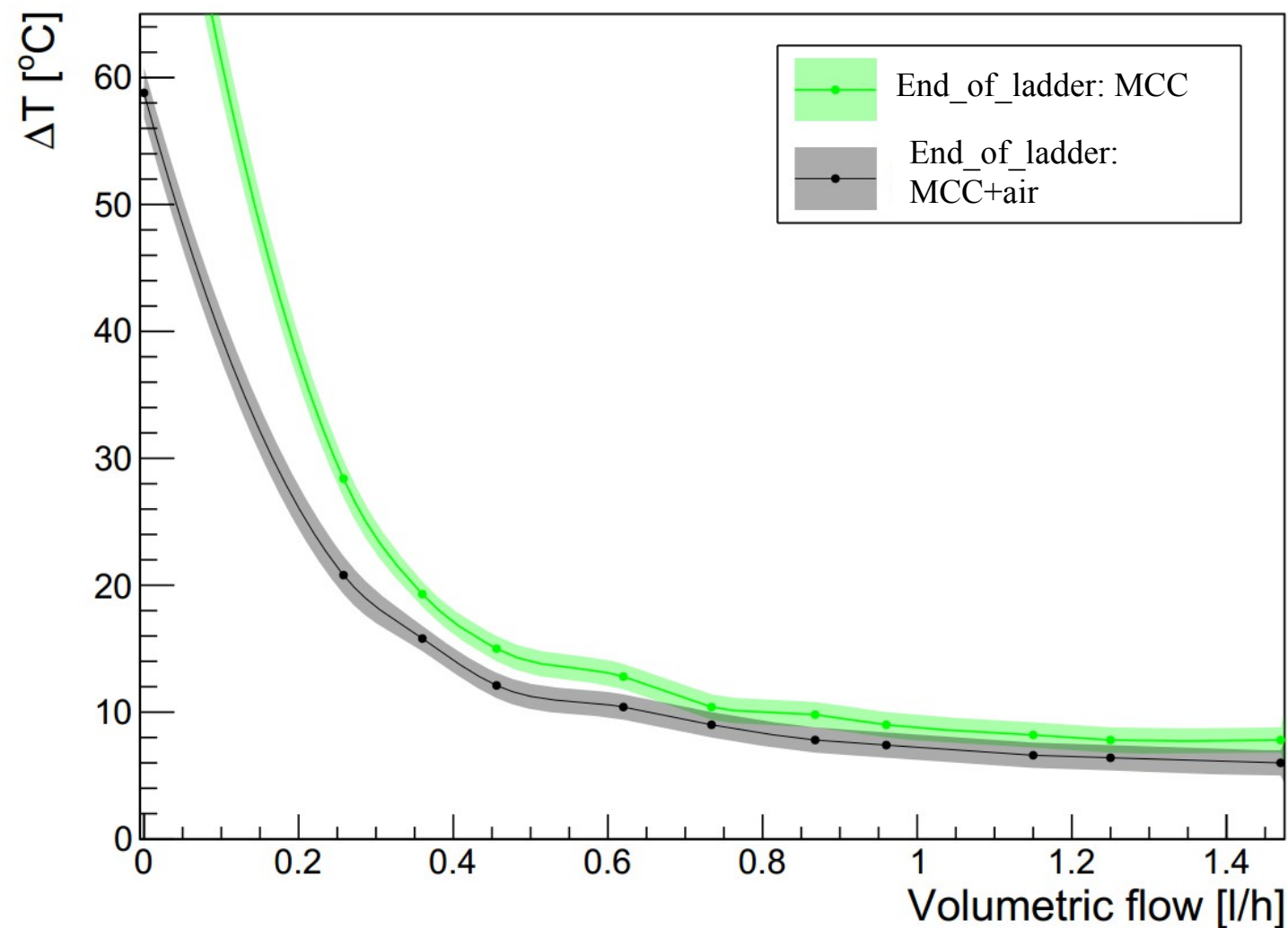
Air
(0,5 m/s)

- Farthest regions to the air inlet are not affected by

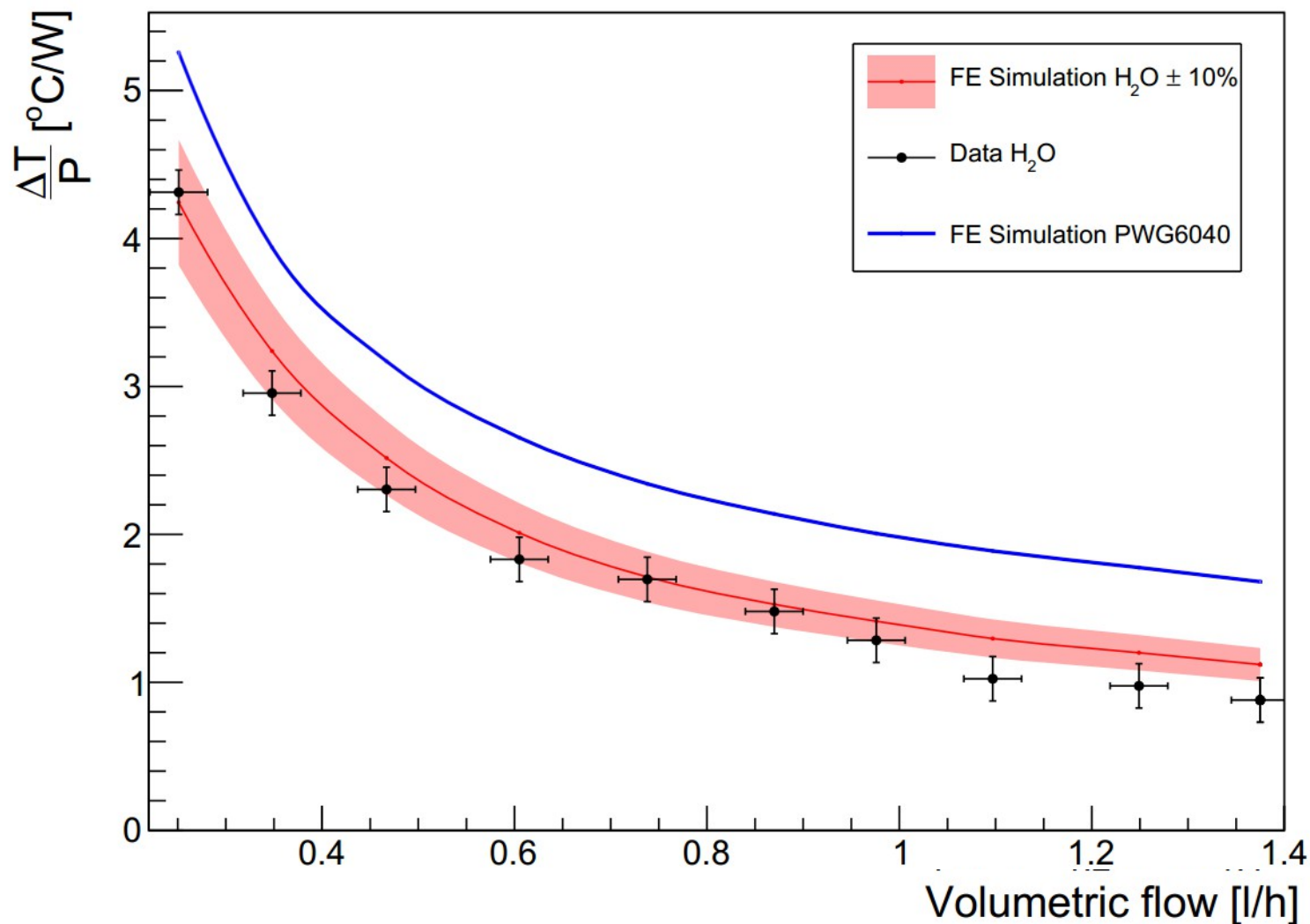
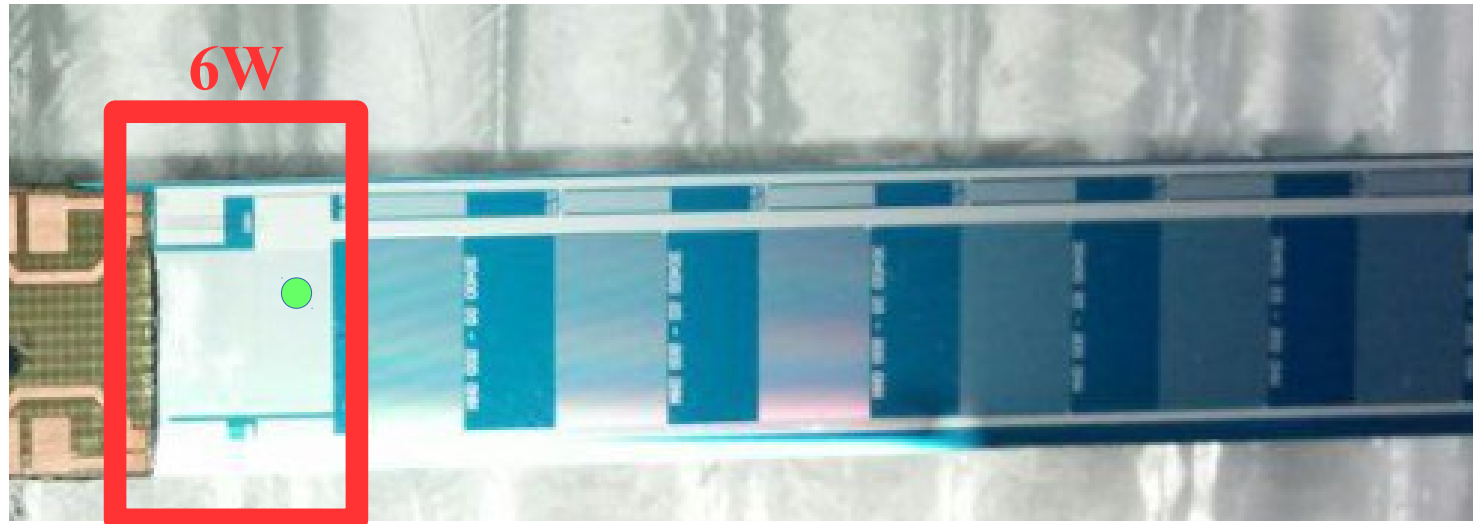
- No big difference between MCC and MCC+air

- Even with low vol. **water** Flow, high cooling

- 93% of total heat cooled by MCC



Test results: MCC

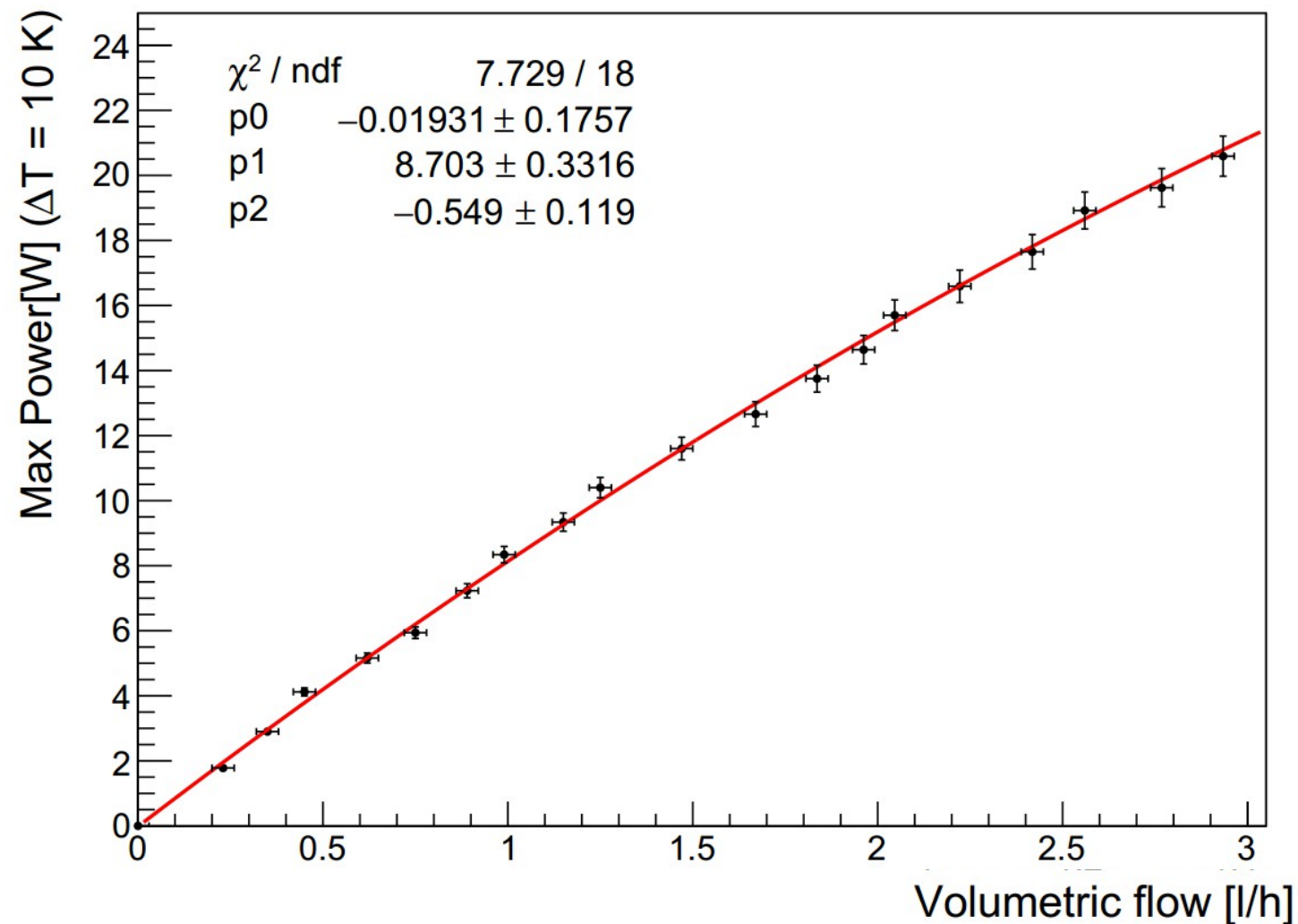
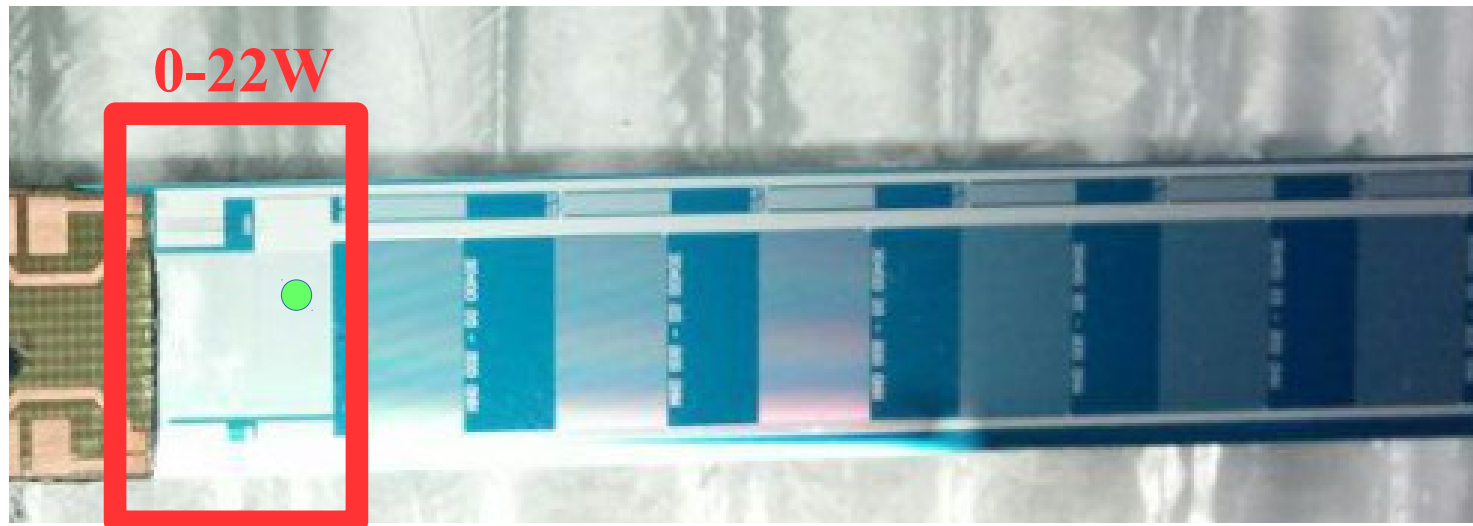


- Good agreement with simulation inside a 10% area

- Additional coolant simulated (60% glycol + 40% water)

- Measurement errors:
1% Power
1°C Temp
+/- 0,02 l/h

Test results: MCC for $\Delta T=10\text{K}$



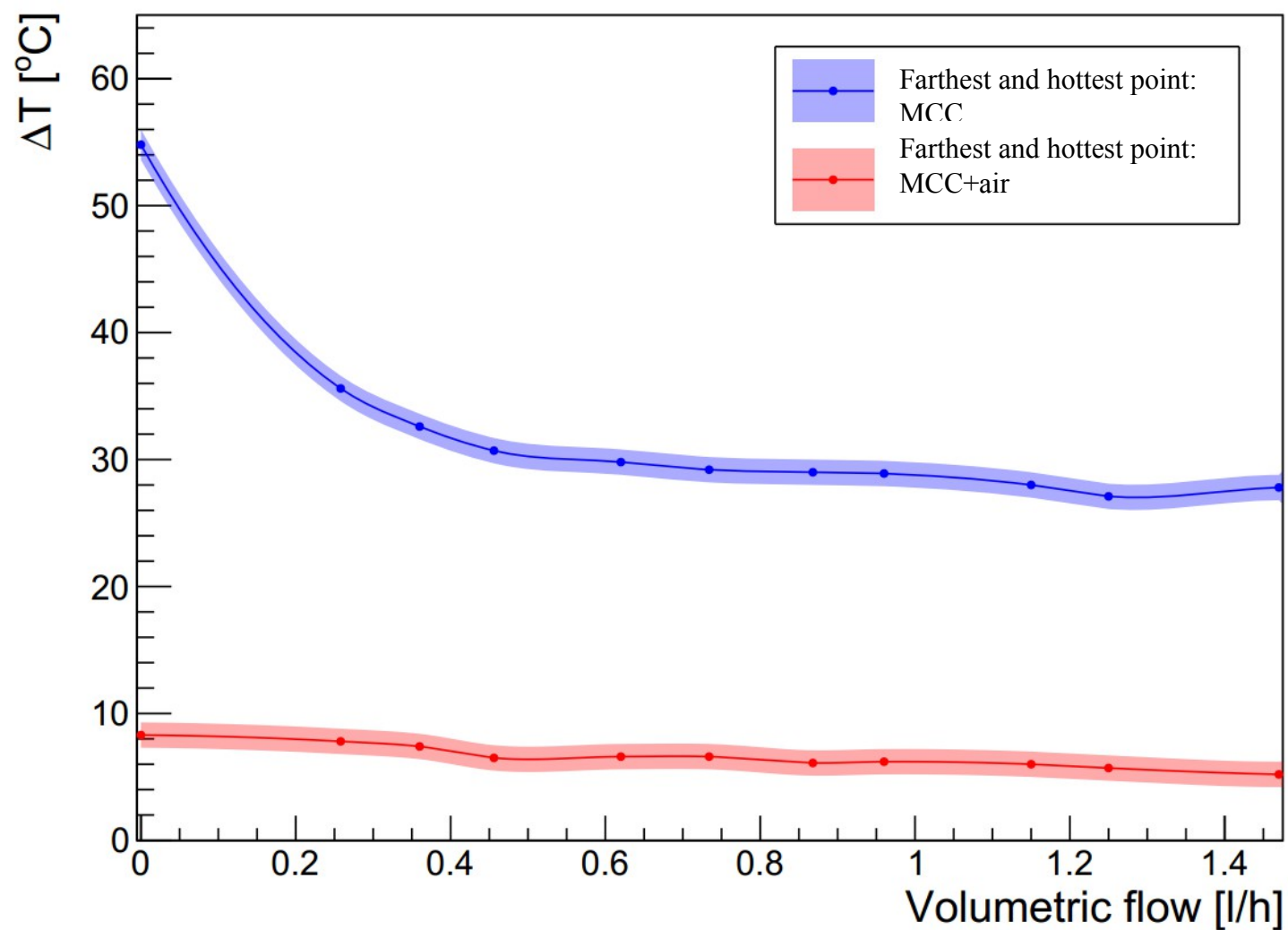
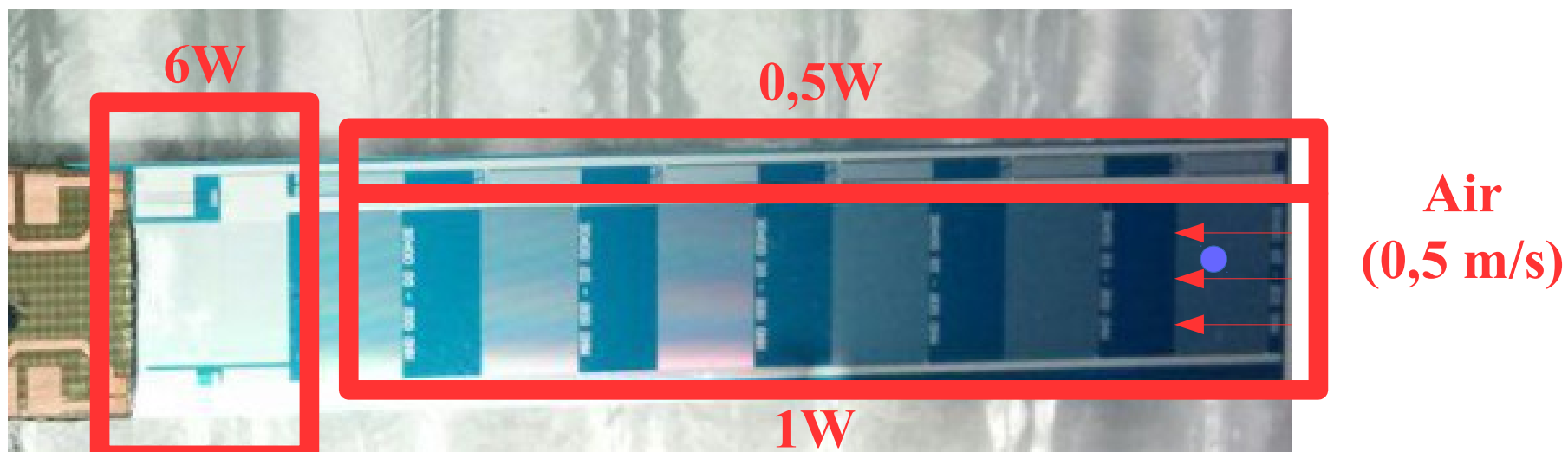
- T stability even with $25\text{W}/\text{cm}^2$

- $\Delta T(\text{hottest point})/P$ vs Q at max. pump power: limit not in sight

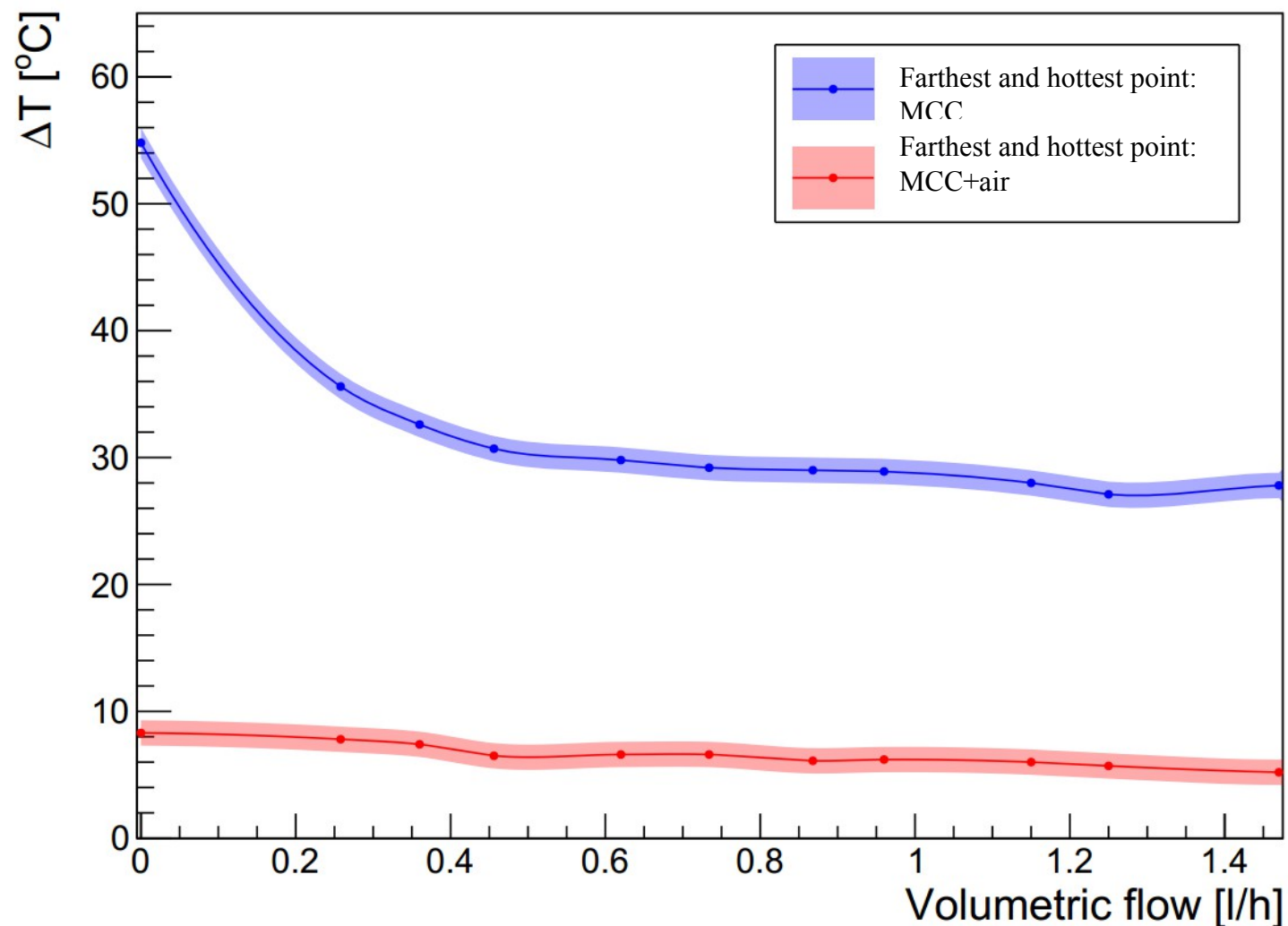
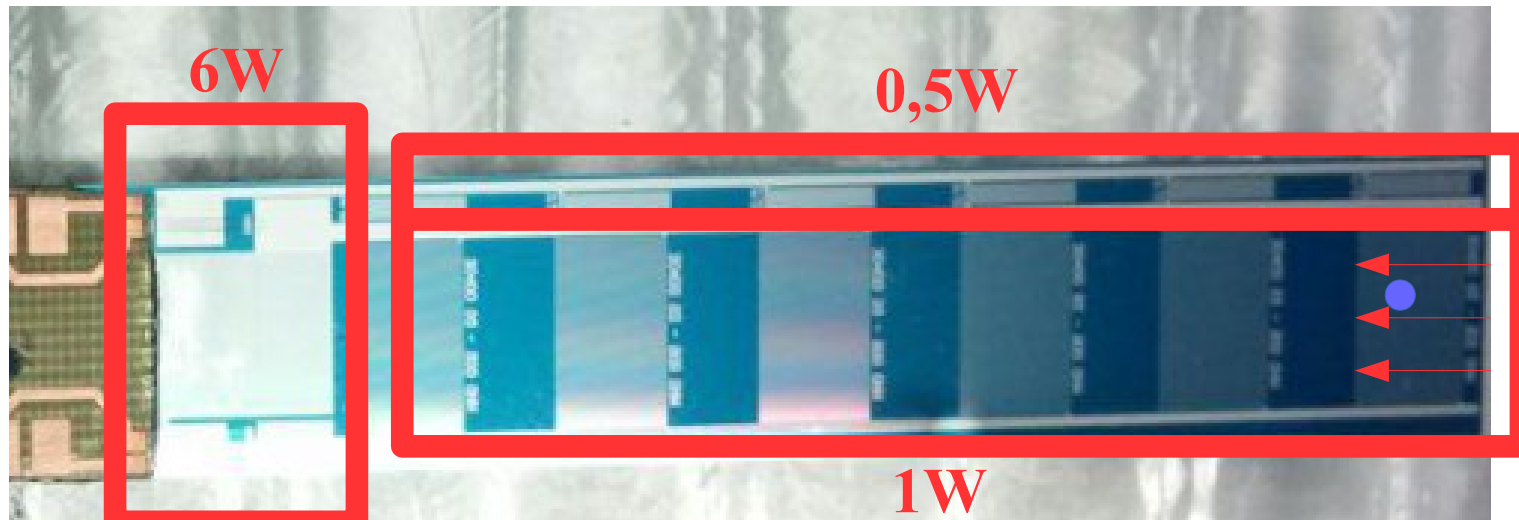
- Low pressure drop: about 1,5 bar



Test results: MCC+air (far from MCC region)

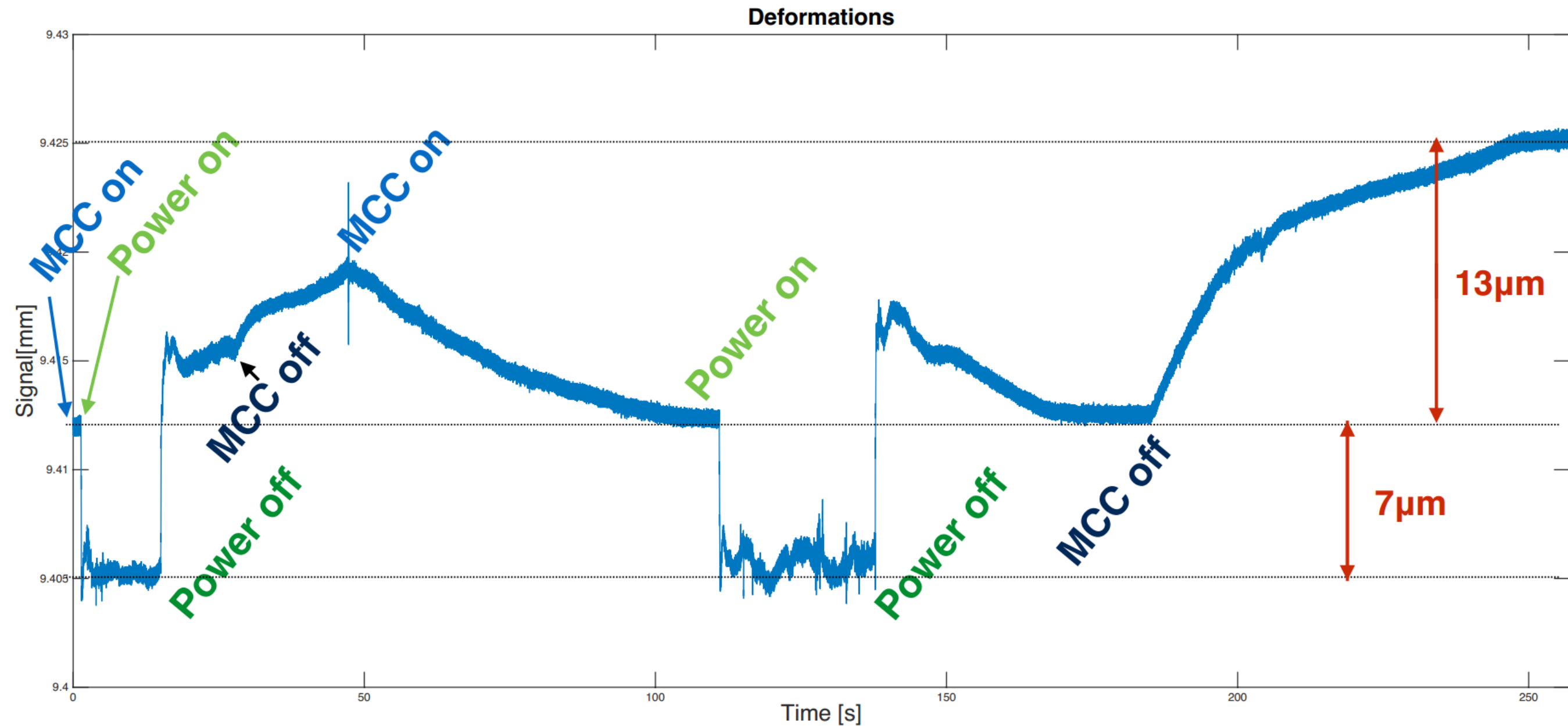


Test results: MCC+air (far from MCC region)



- Nearest regions to air input is sufficient
- Big difference between MCC and MCC+air
- Even with low vol. **Air** flow, high cooling

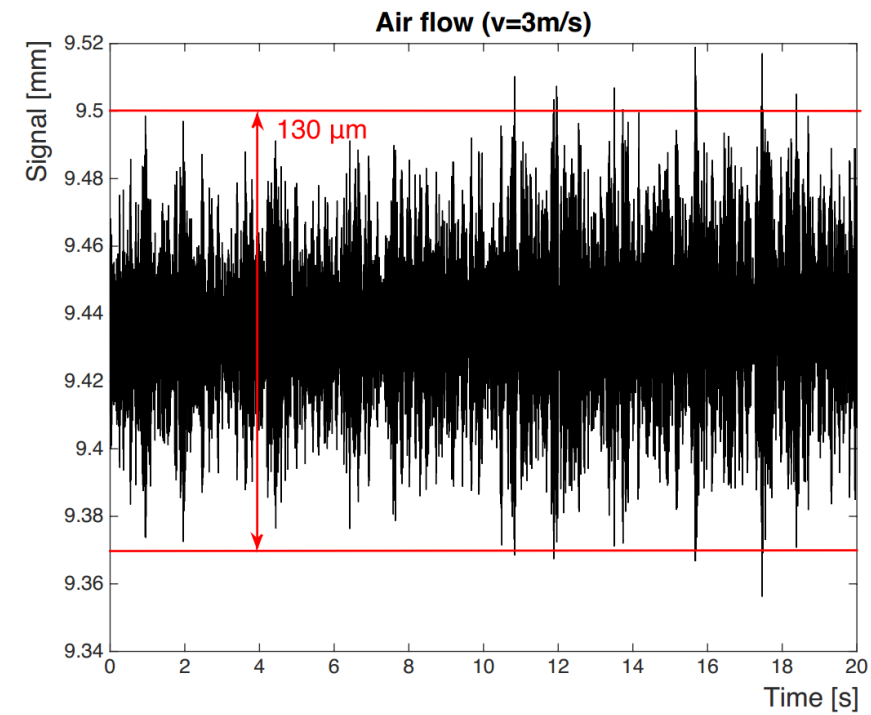
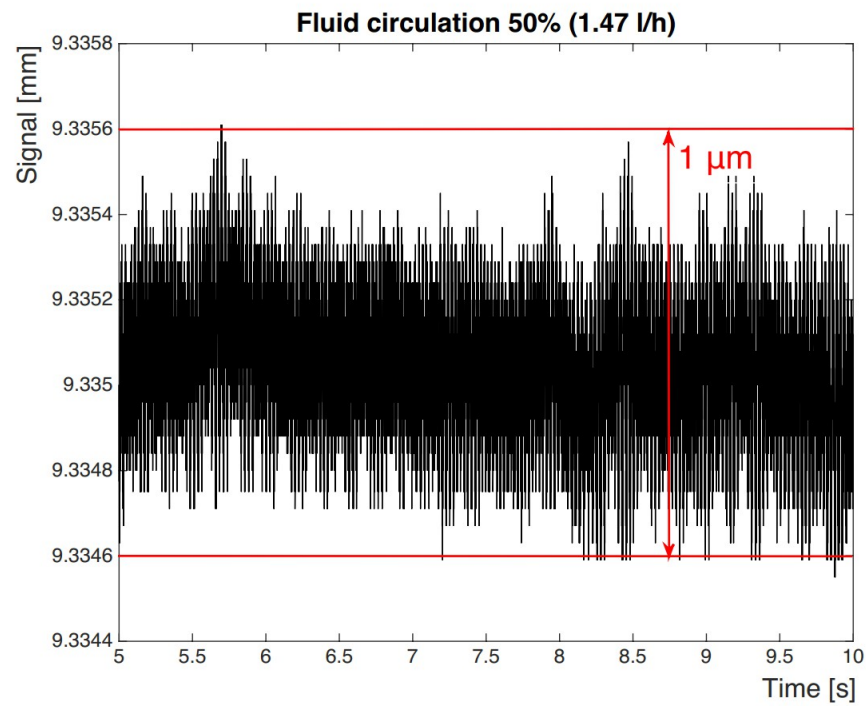
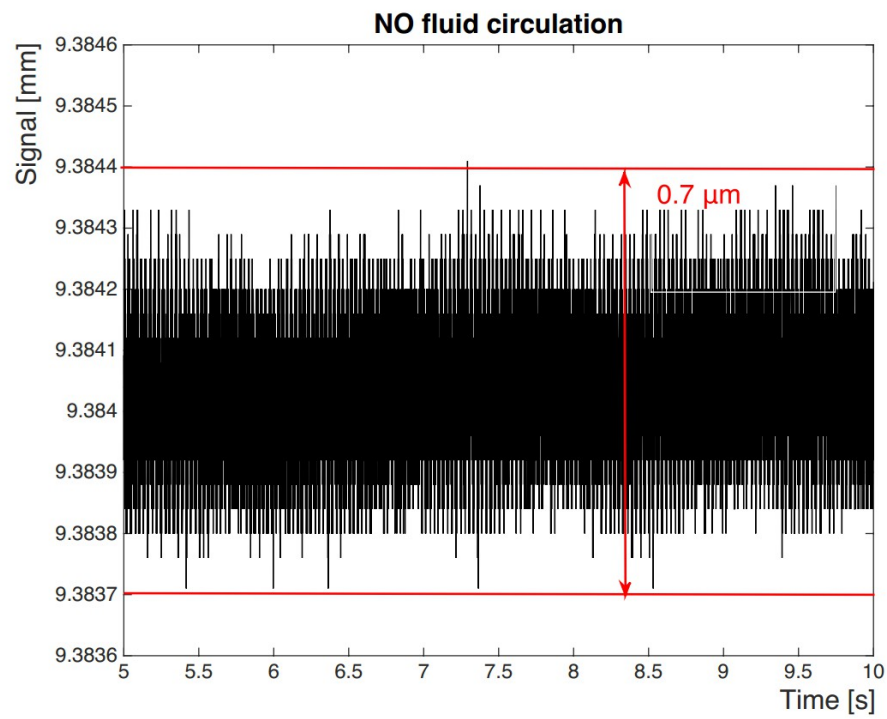
Test results: out-plane static deformation



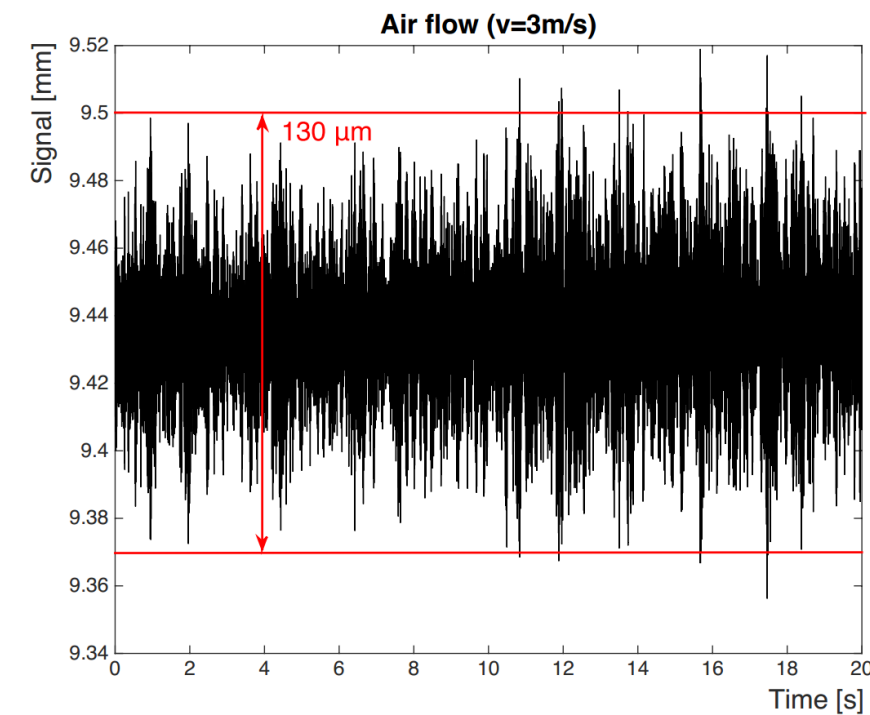
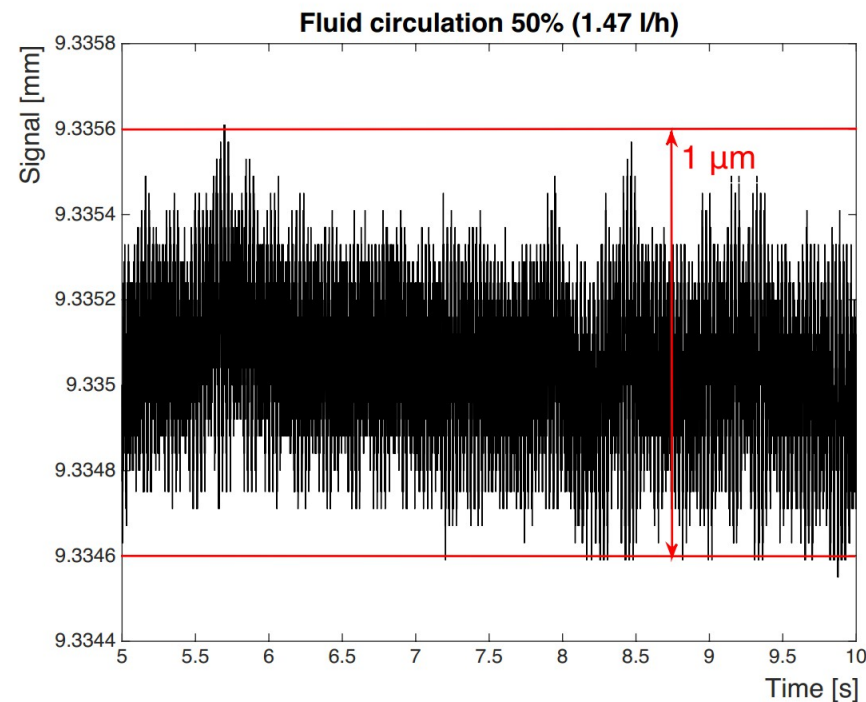
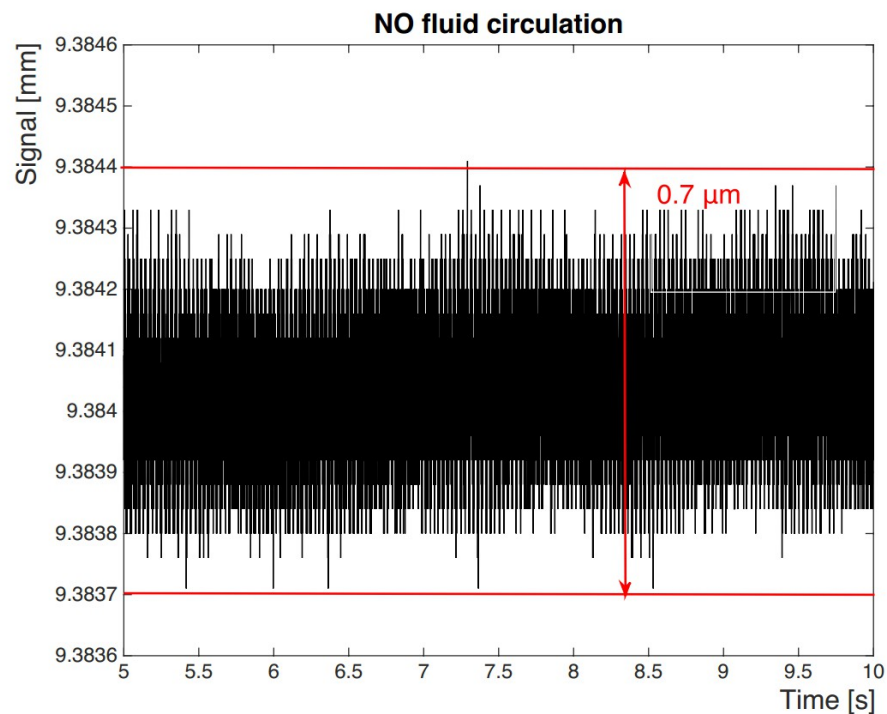
- Minor deformations observed in transitions regions
- Mechanical stability after cycles
- 7 μm between power on-off



Test results: out-plane dynamic deformation



Test results: out-of-plane dynamic deformation



- MCC has no significant impact on mechanical stability
- In Clamped-Free (Cantilever) configuration air deformations are about 130 μm if $v=3\text{m/s}$
- RMS (no circulation): 0,3 μm
RMS (liquid circulation): 0,5 μm
RMS (air cooling 3m/s): 57 μm



Conclusions

- we have presented a low-pressure single phase MCC solution with in-plane connections
- reliable connections to conventional circuit -> controlled measurements
- very efficient cooling; up to 25 W/cm² with minimal temperature increase (10°C) in MCC region
- thermal measurements are in good agreement with FE simulation
- MCC minimal impact on mechanical stability
- Easy and robust assembly (3/3) with a 3D printed adaptor
- MCC embedded in a Si sensor is a real option

